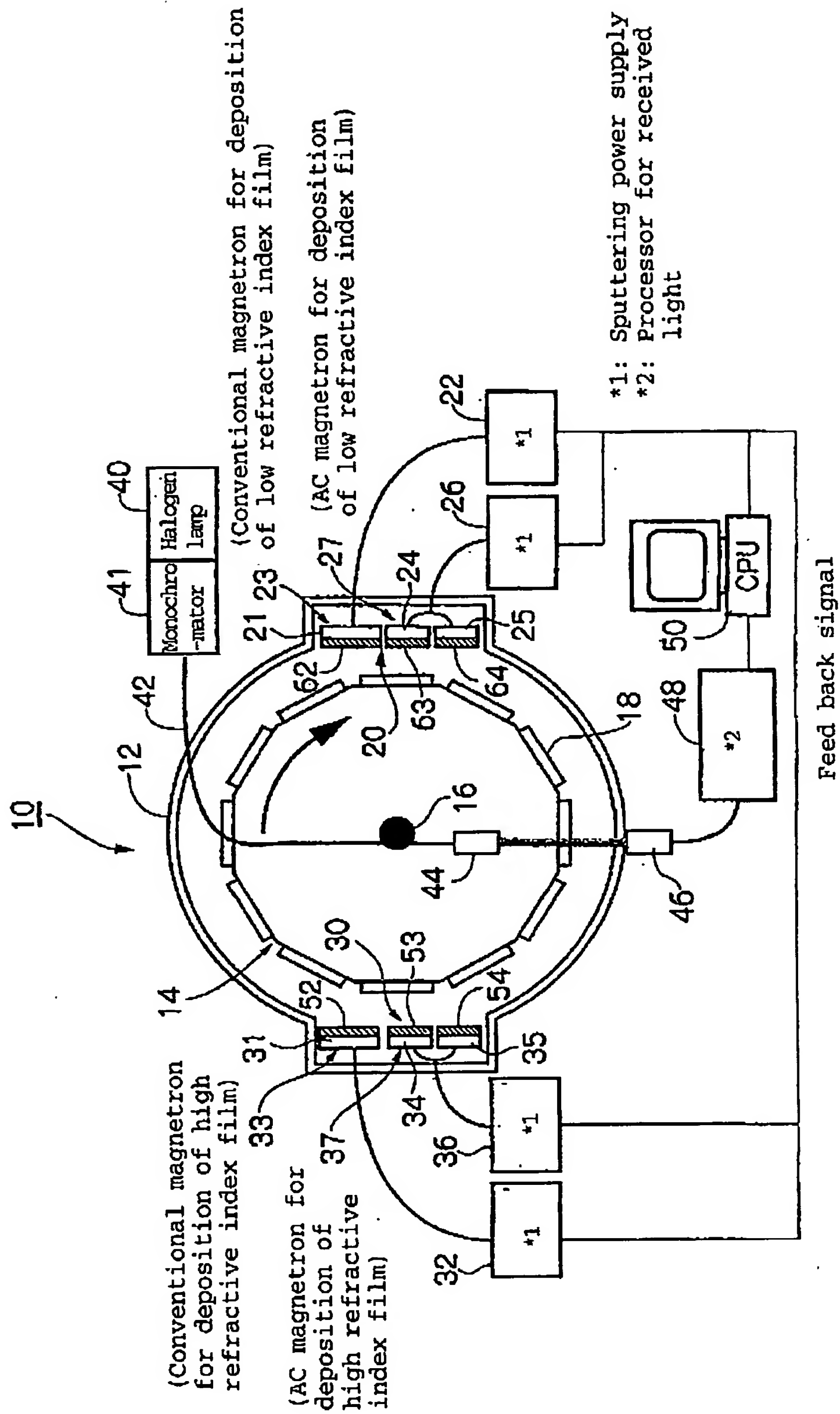


Fig. 1



F i g . 2

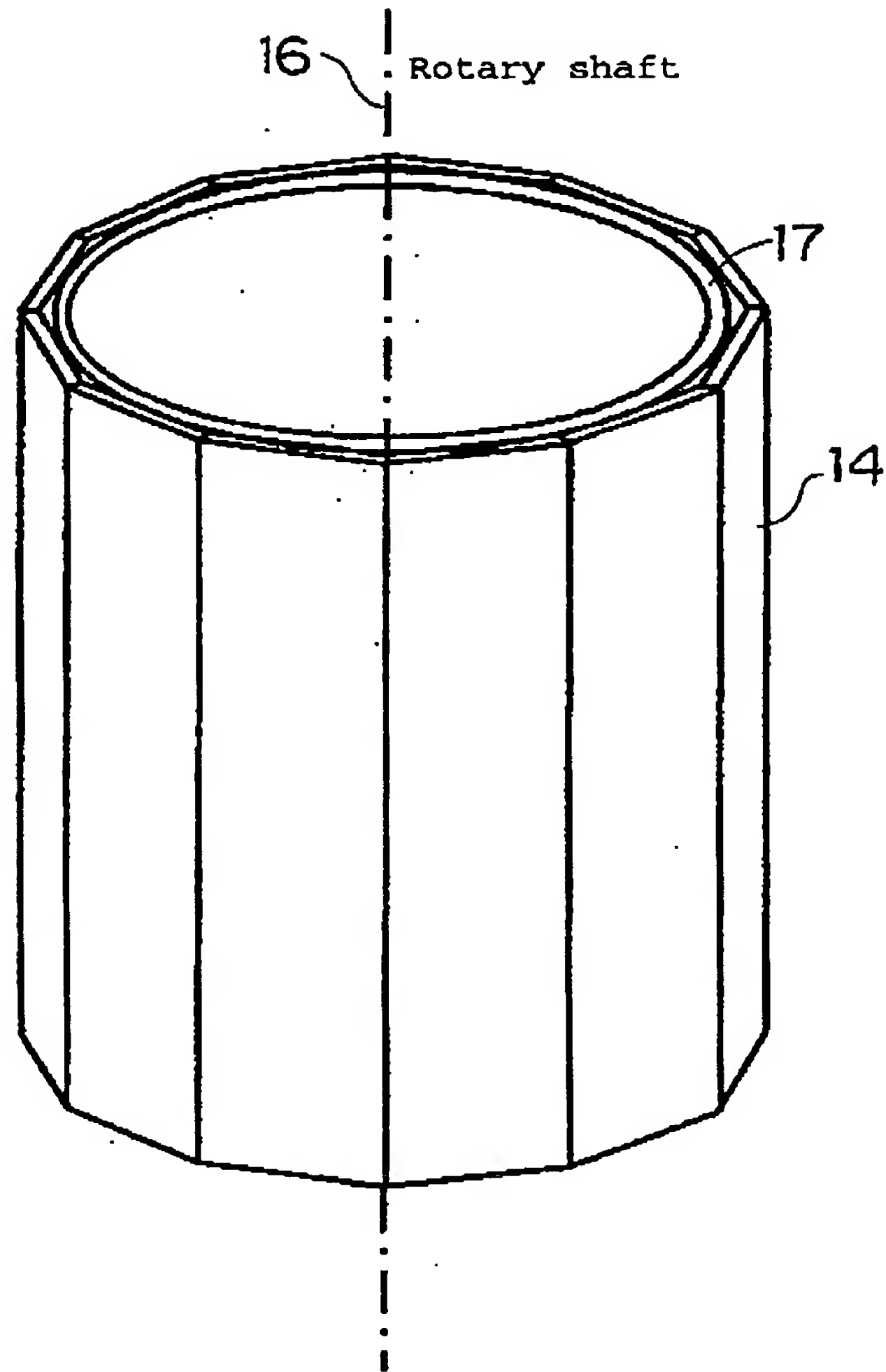


Fig. 3

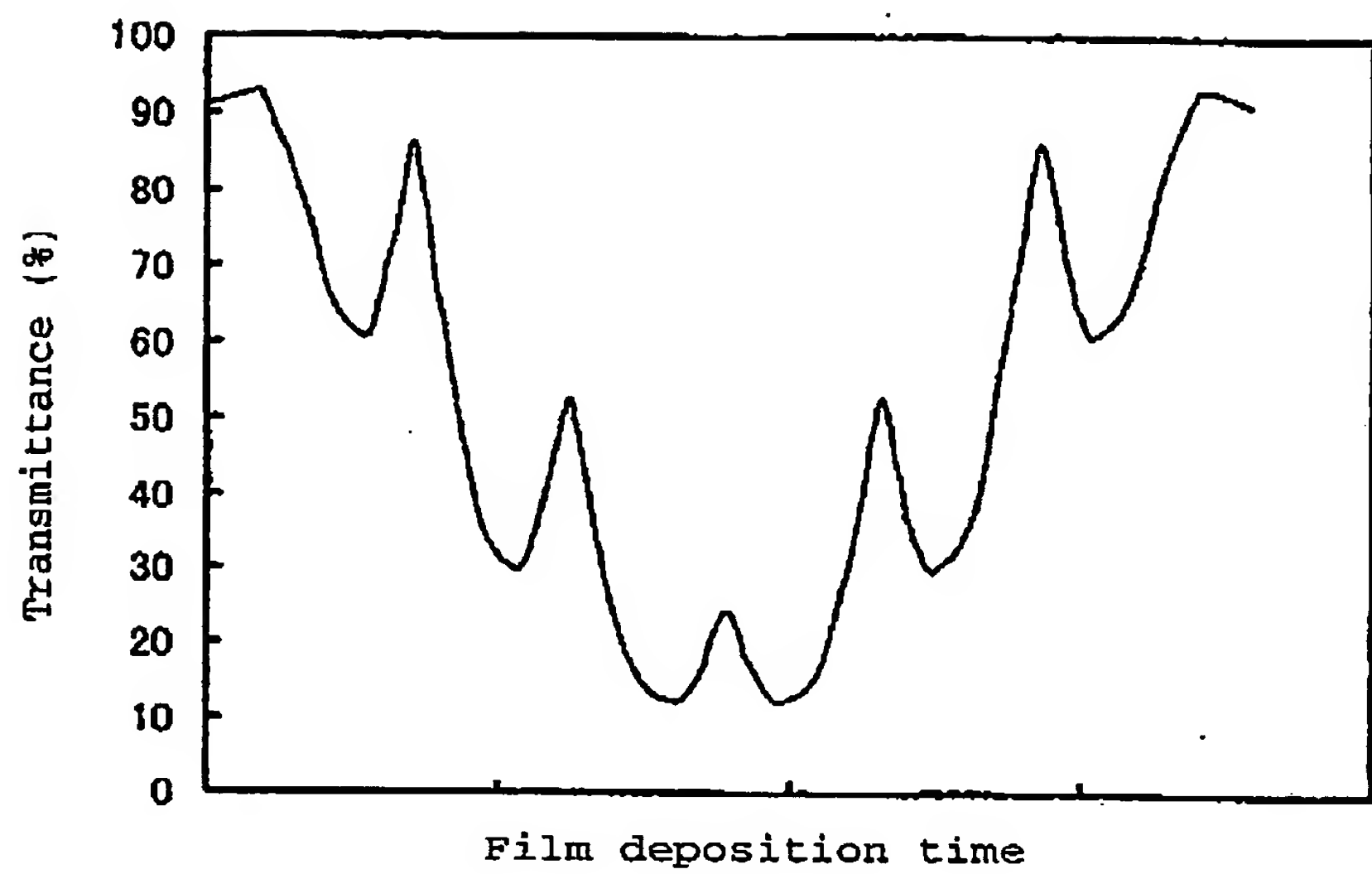


Fig. 4

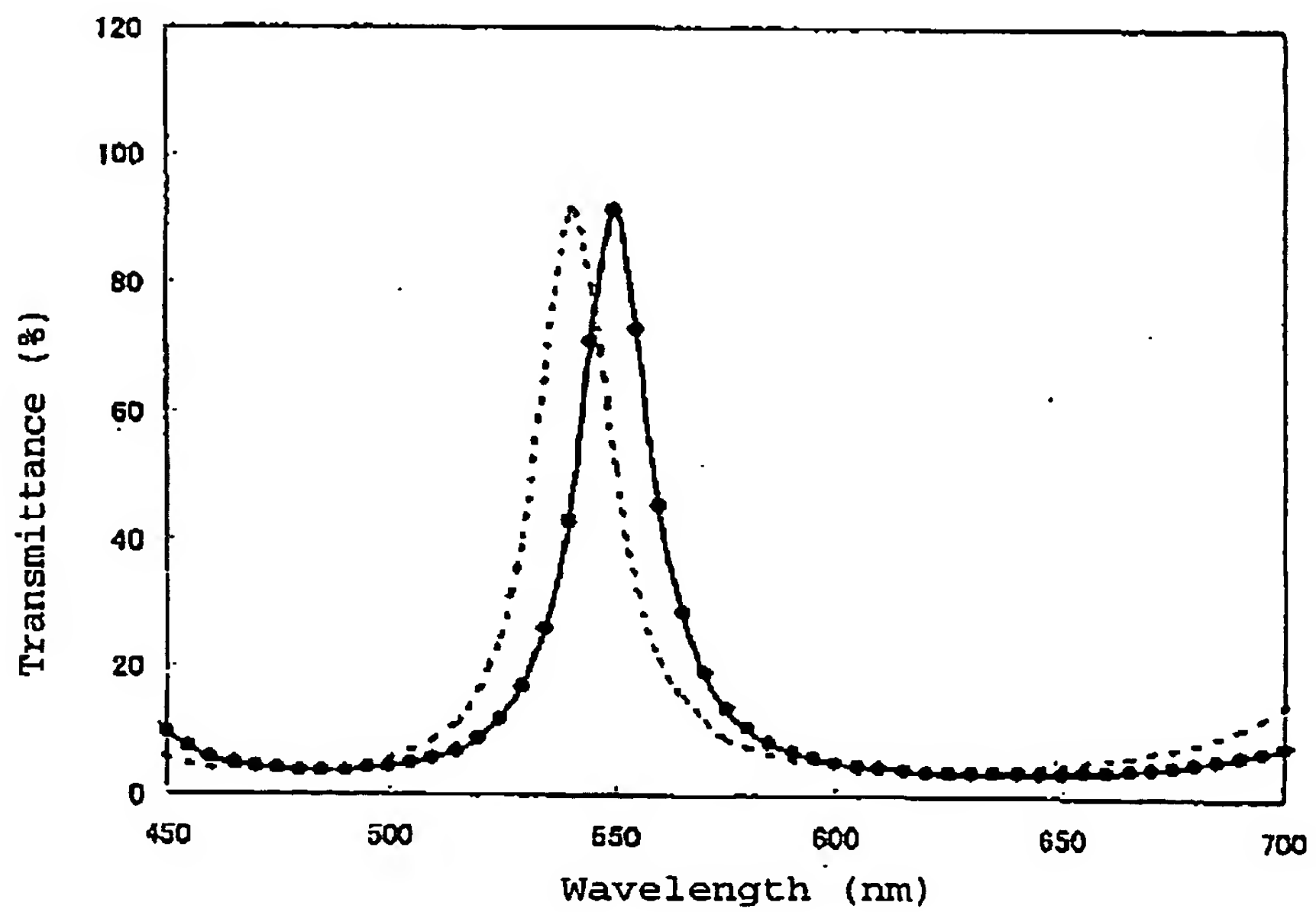


Fig. 5

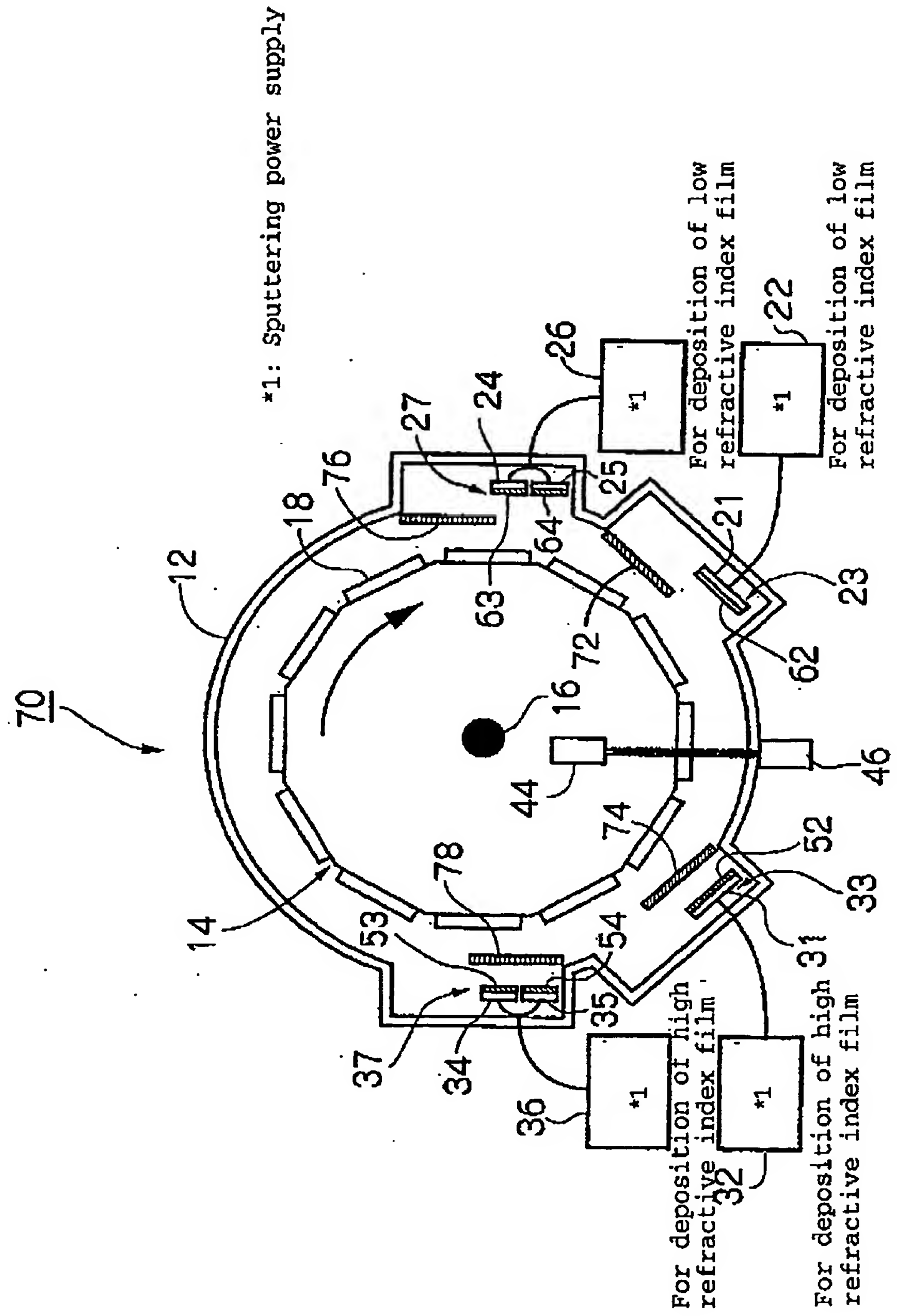


Fig. 6

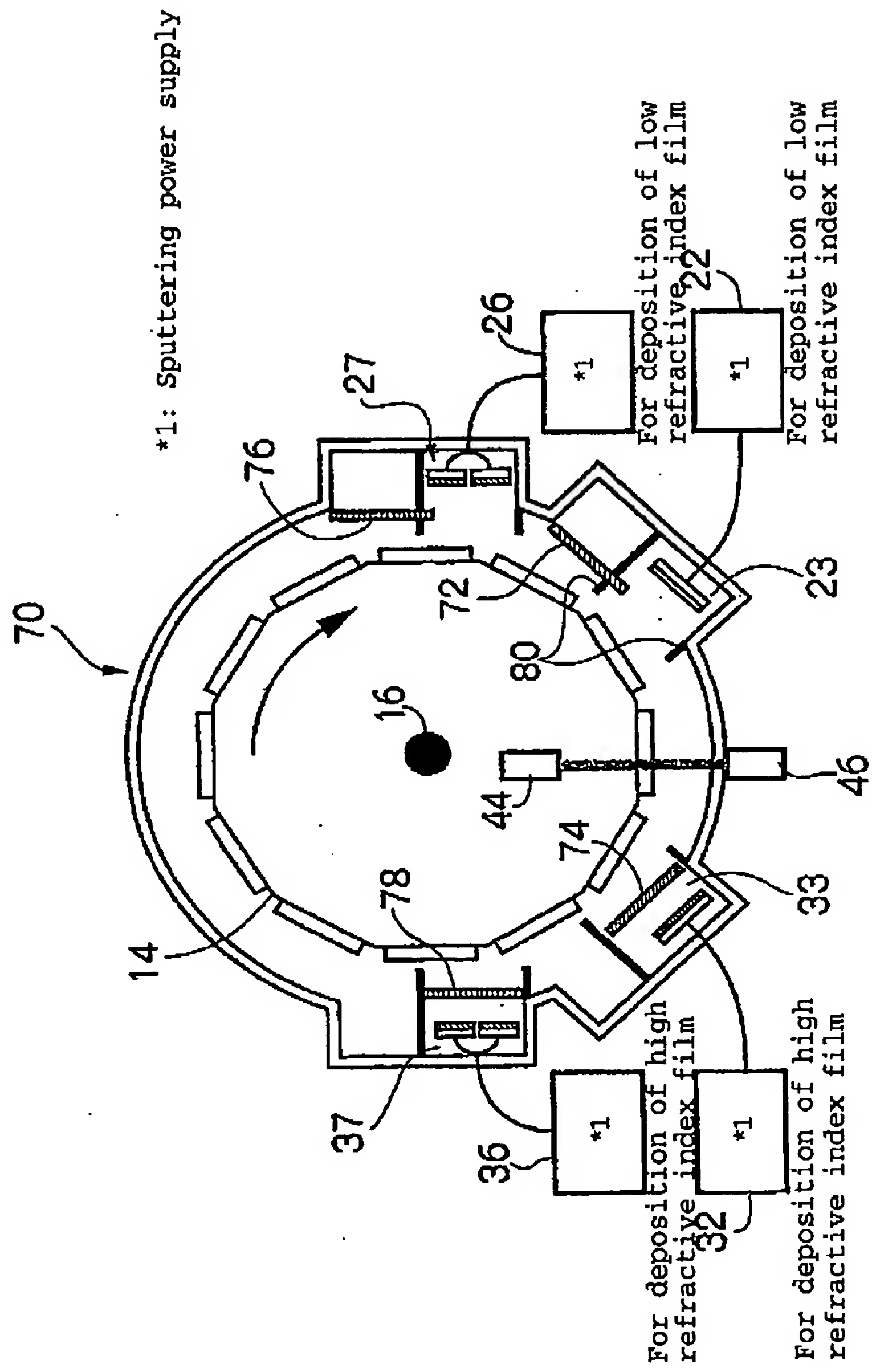


Fig. 7(a)

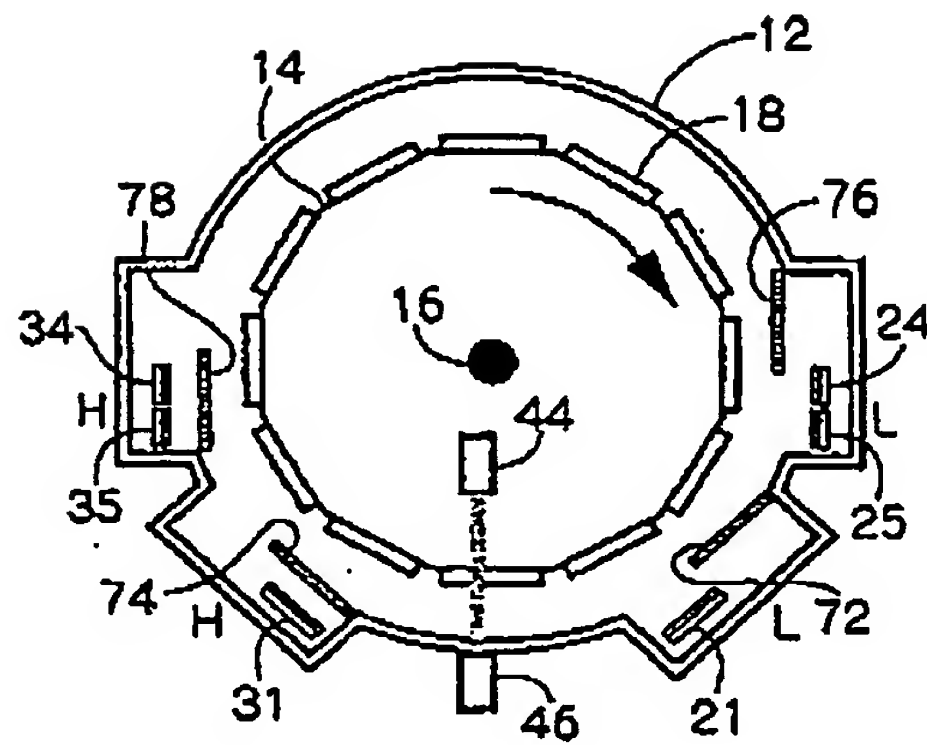


Fig. 7(b)

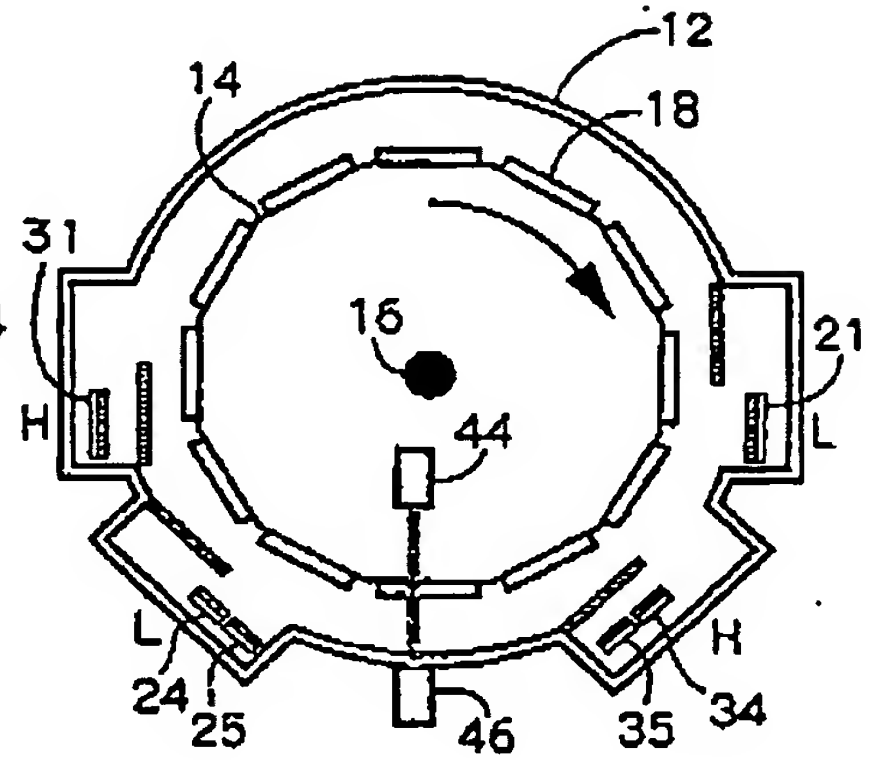


Fig. 7(c)

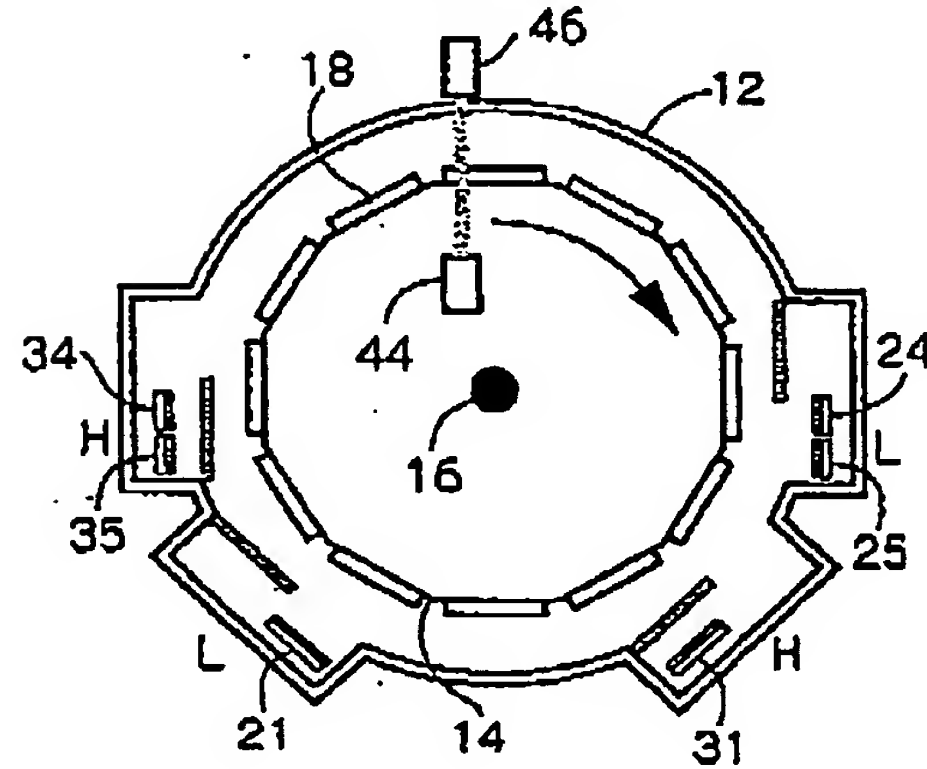
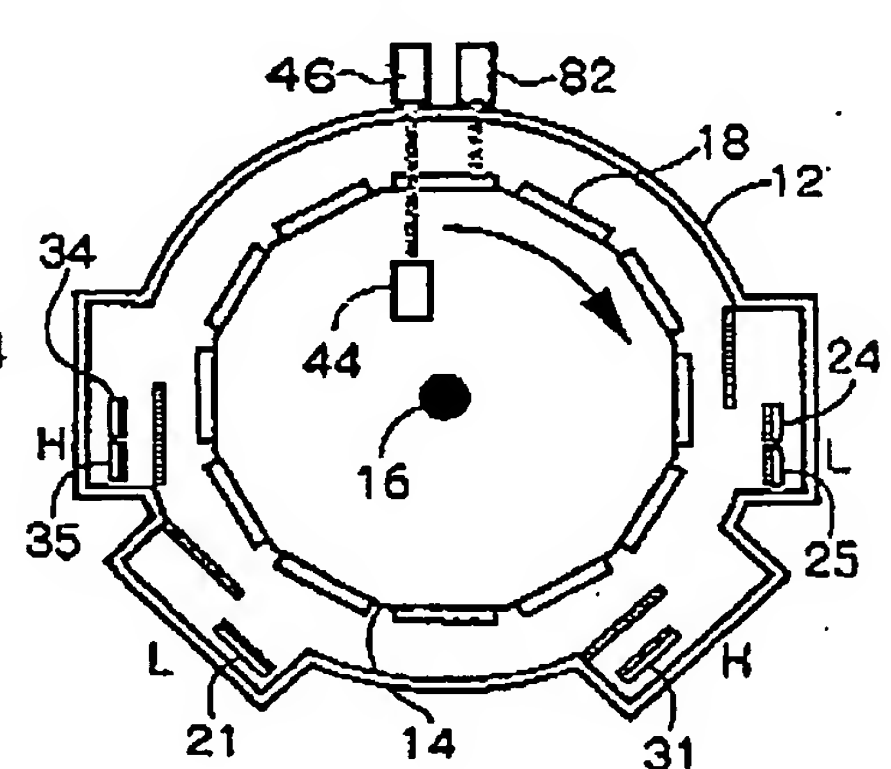


Fig. 7(d)



F i g . 8

	Target material	Film material
Low refractive index material	Si	SiO ₂
	SiC	SiO ₂
	Alloy of Si and Al	SiO ₂ + Al ₂ O ₃
High refractive index material	Ti	TiO ₂
	Ta	Ta ₂ O ₅
	Zr	ZrO ₂
	Zn	ZnO
	Nb	Nb ₂ O ₅

F i g . 9

Examples of substrate used in the present invention

For WDM	WMS manufactured by OHARA Corporation (glass ceramics)
For optical filter	Colorless sheet glass (high transmittance glass)
	Hard glass (low expansion glass)
	Artificial crystal
	Quartz
	BK-7 (optical glass) manufactured by Schott Corporation
	Fluorophosphate glass
	Borosilicate glass

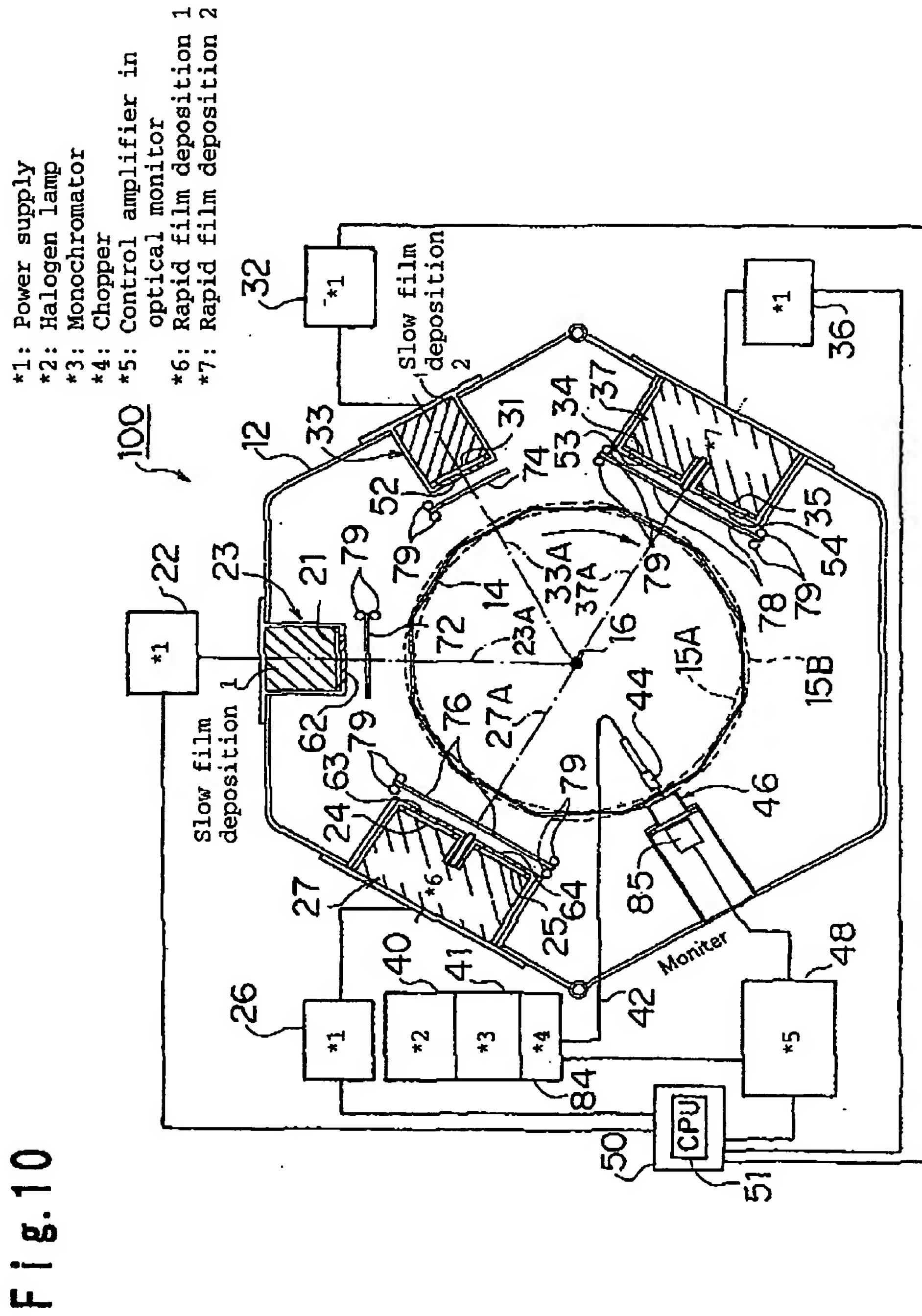


Fig. 11

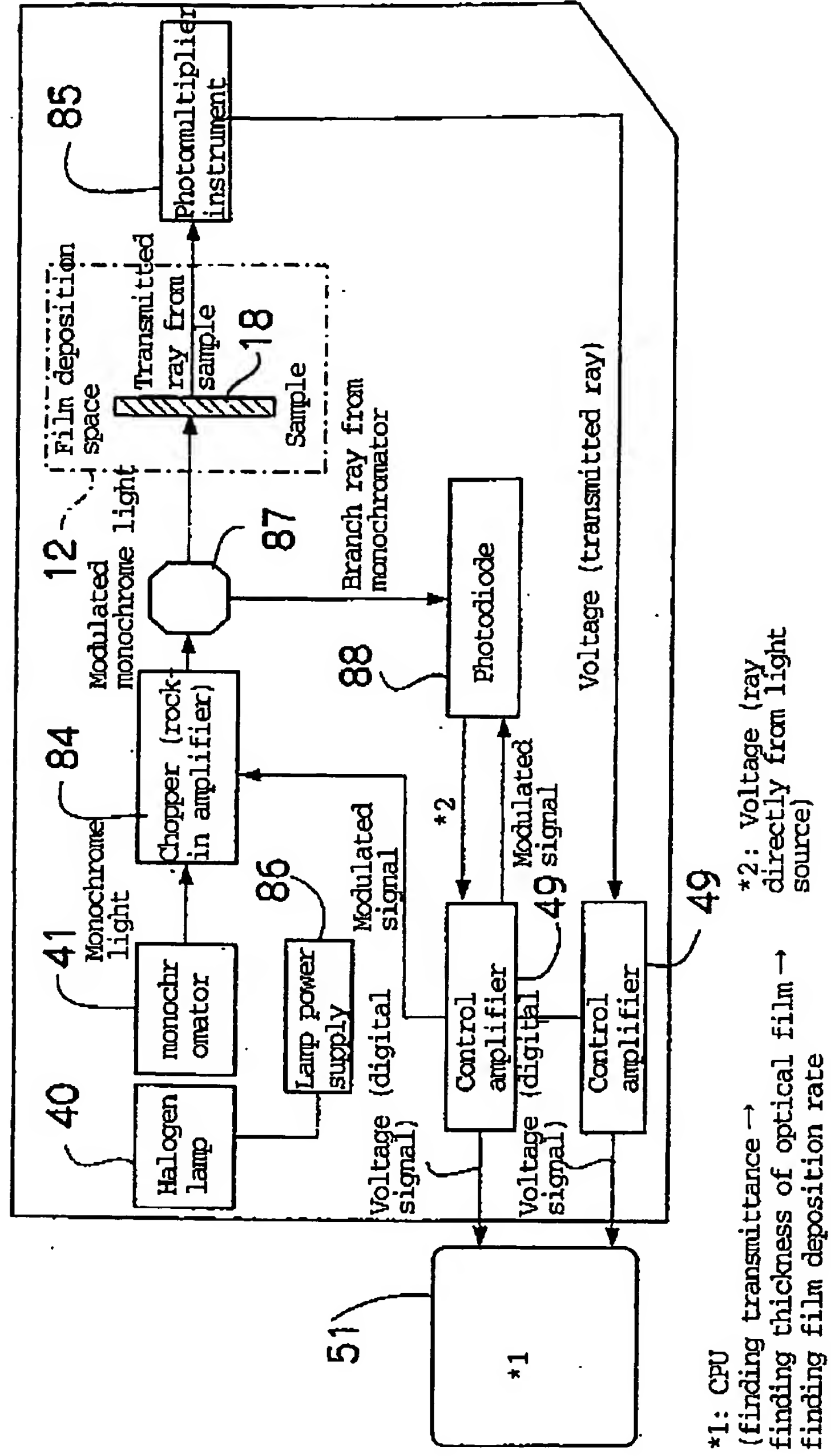


Fig.12

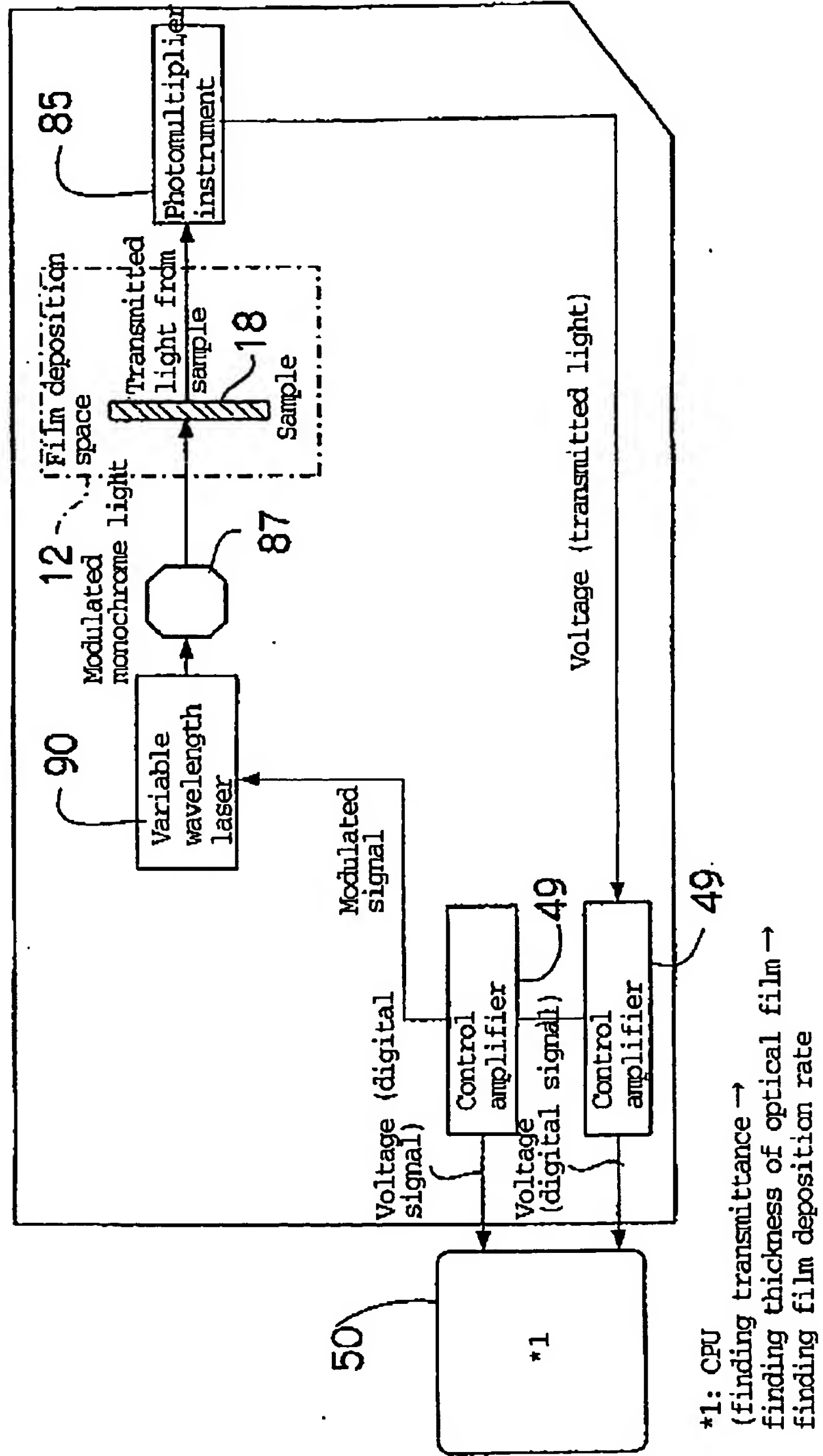


Fig. 13(a)

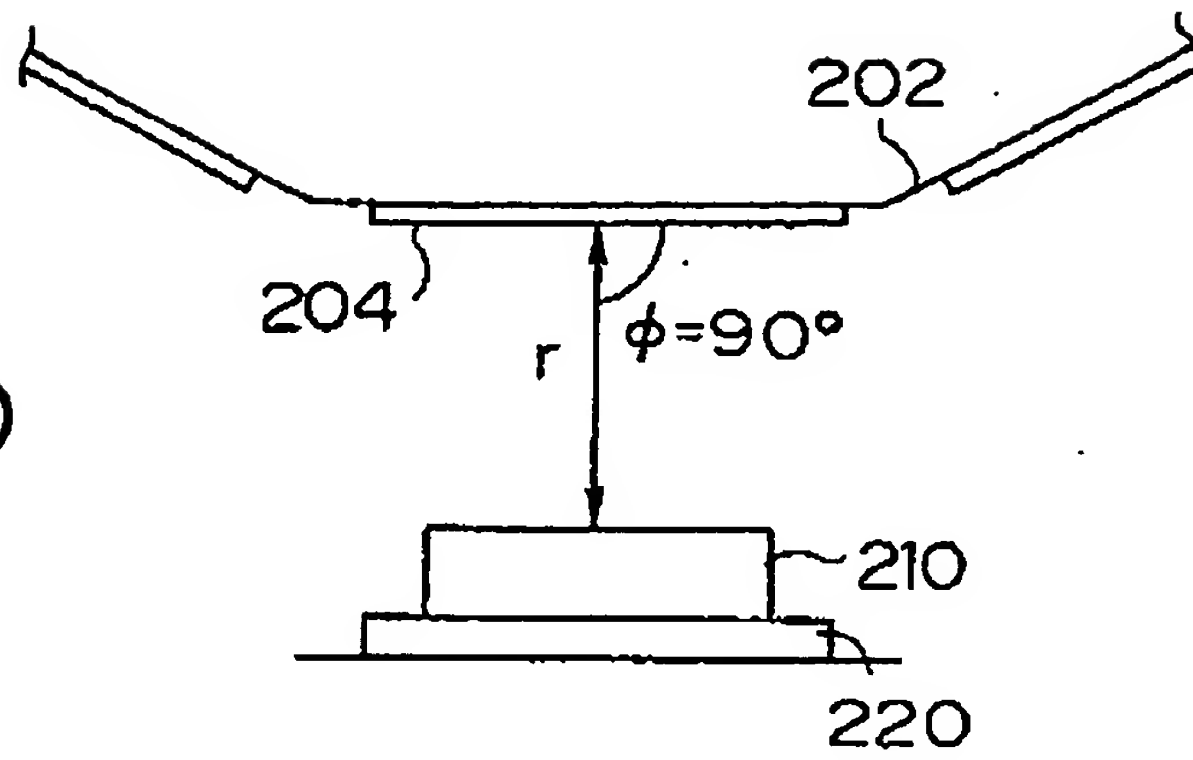


Fig. 13(b)

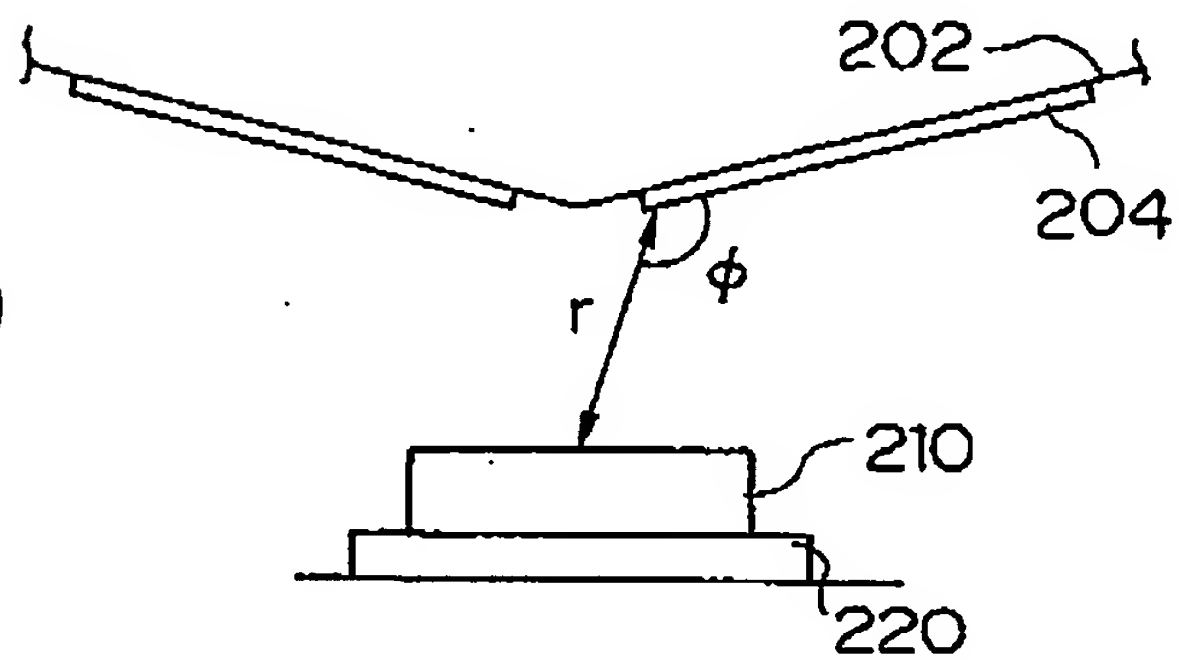
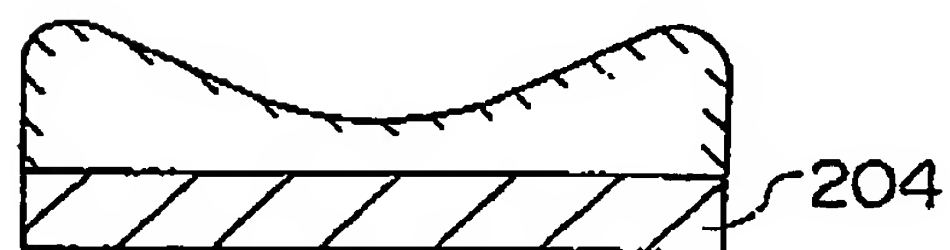


Fig. 13(c)



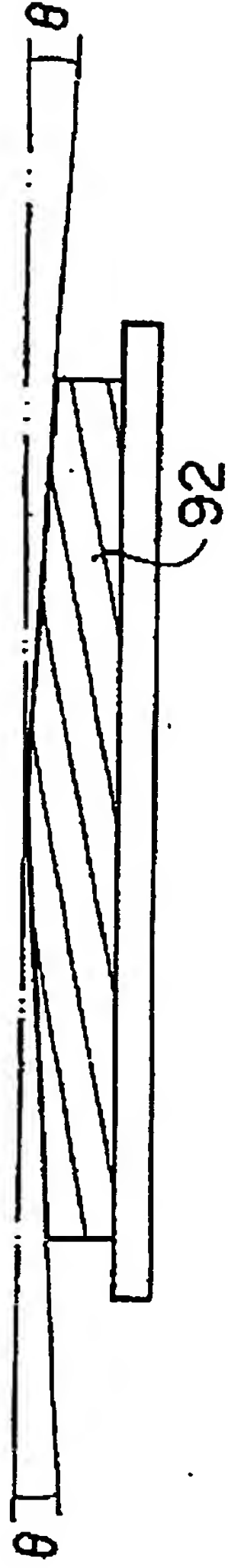


Fig. 14(a)

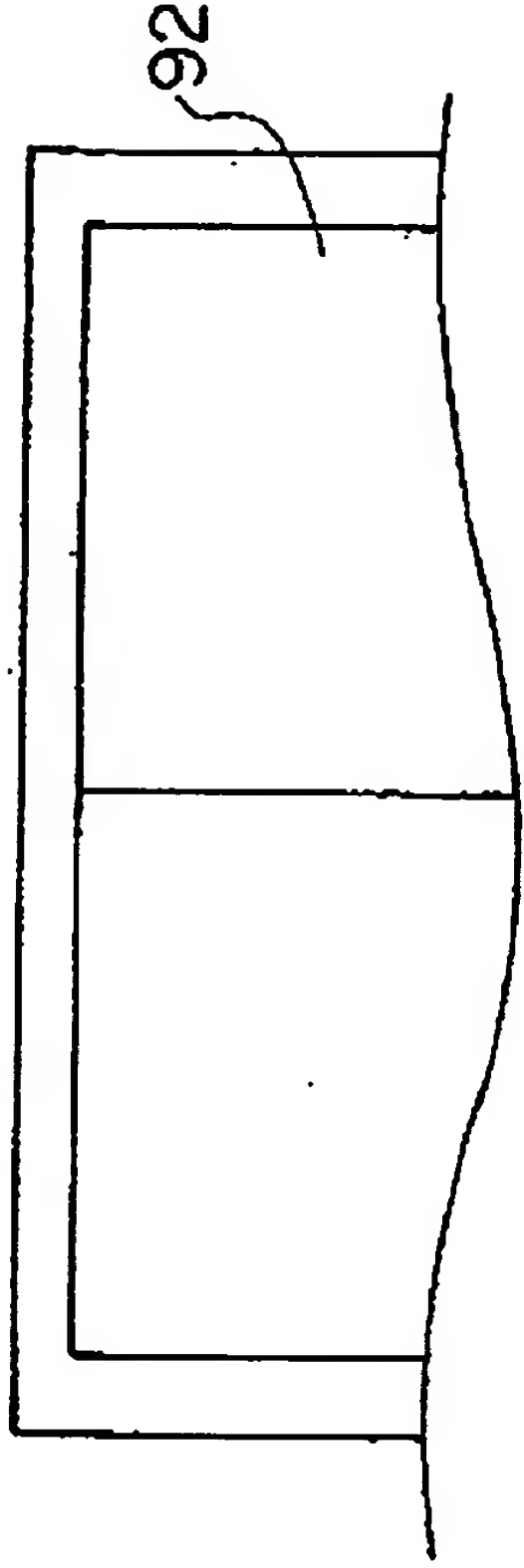


Fig. 14(b)

Fig.15(a)

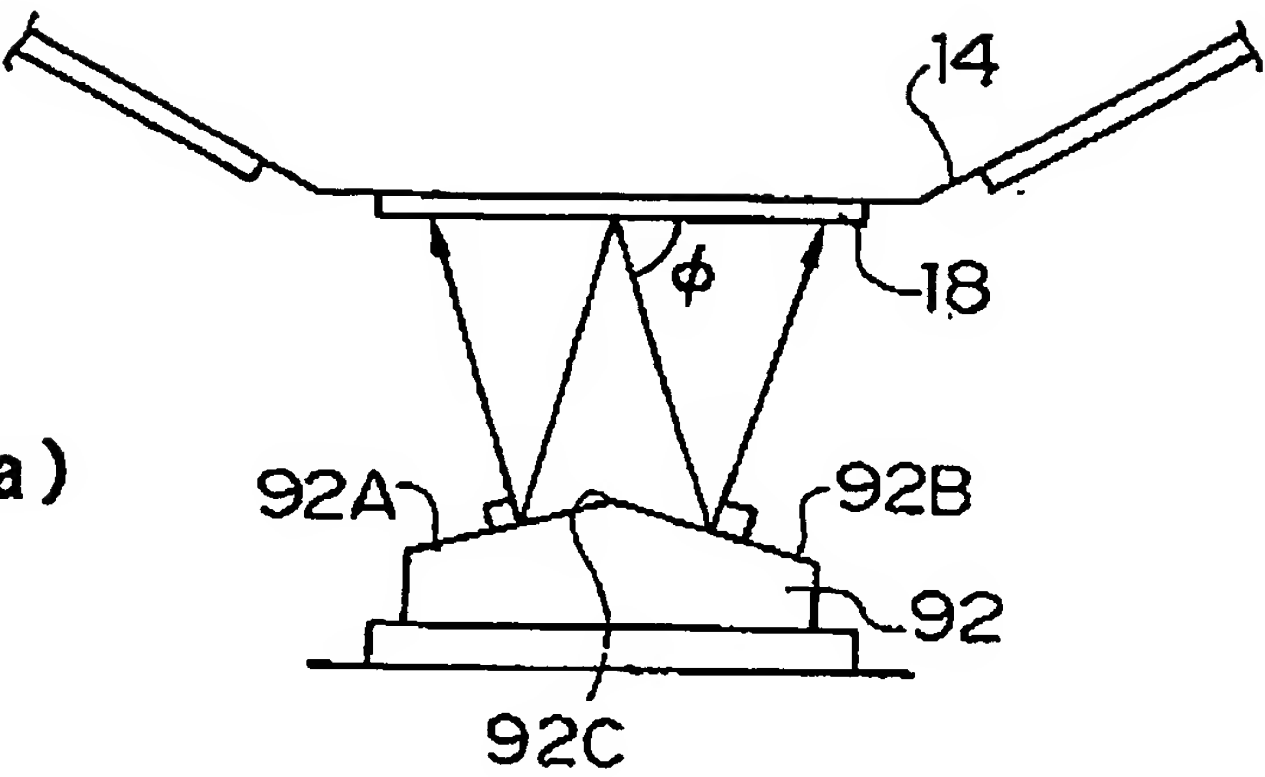


Fig.15(b)

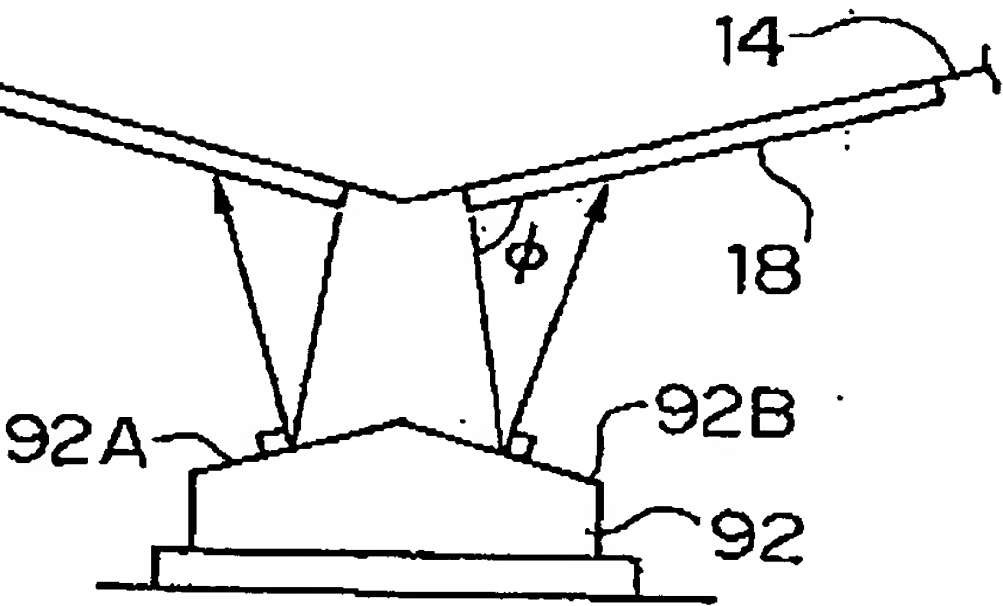


Fig.15(c)

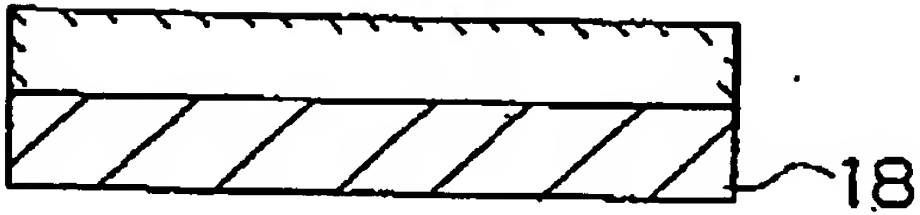


Fig. 16

Distribution in advancing direction by
target for slow film deposition in
carousel type film deposition

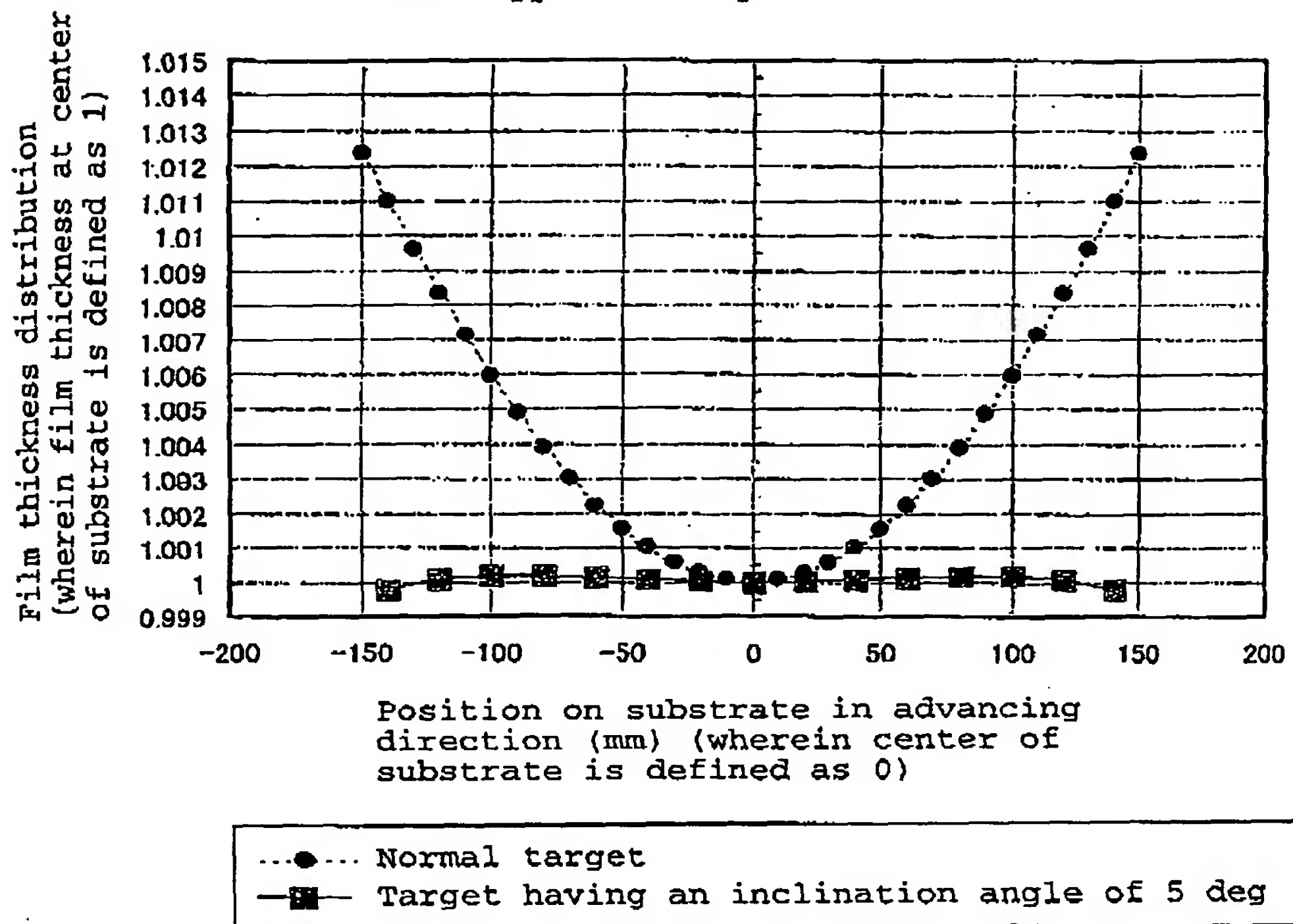


Fig.17(a)

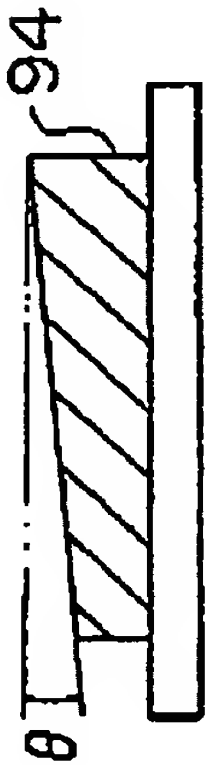


Fig.17(c)



Fig.17(b)

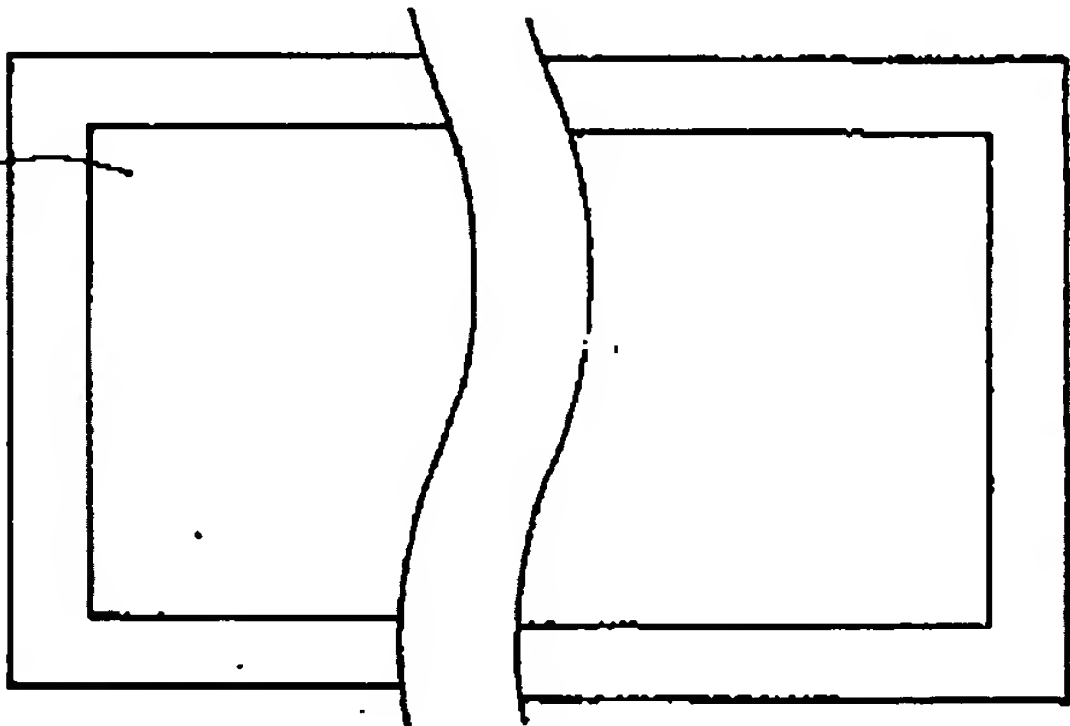


Fig.17(d)

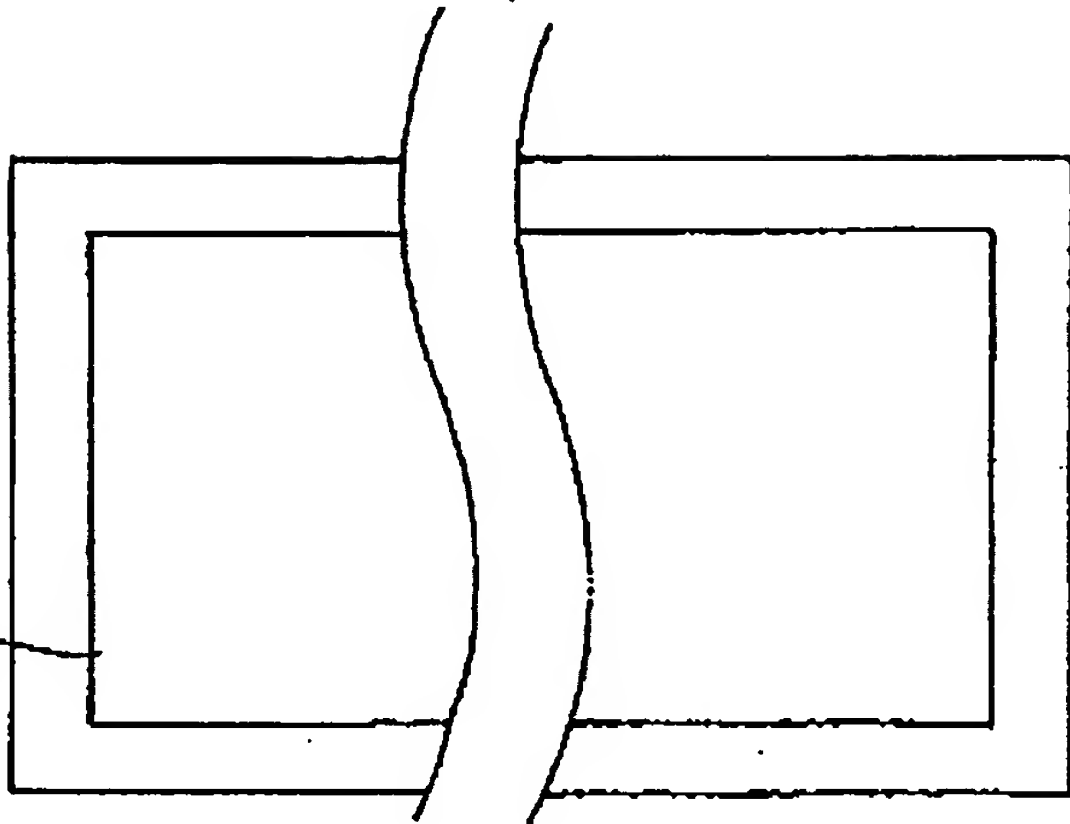


Fig. 18

Distribution in advancing direction by
target for rapid film deposition in
carousel type film deposition

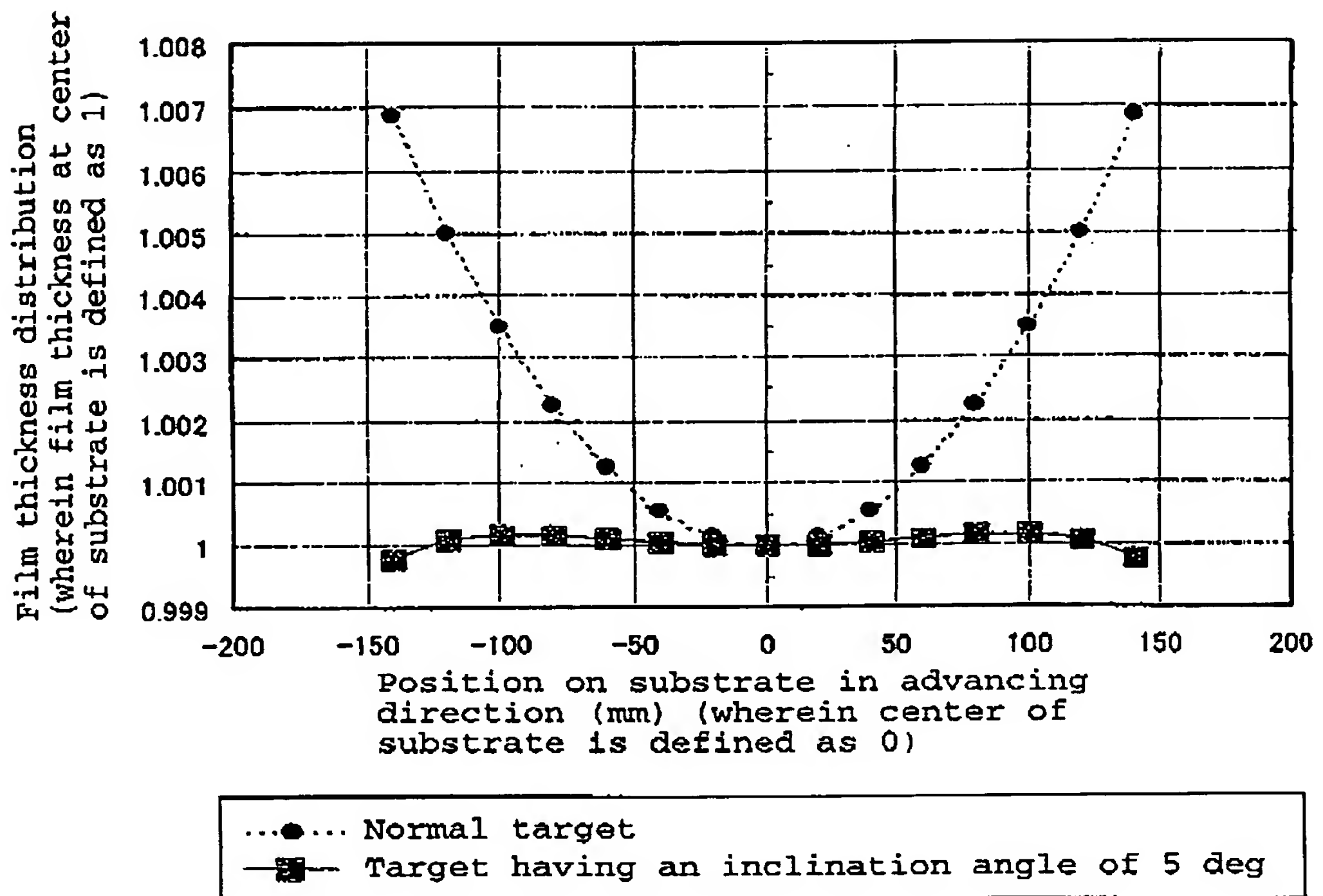


Fig.19(a)

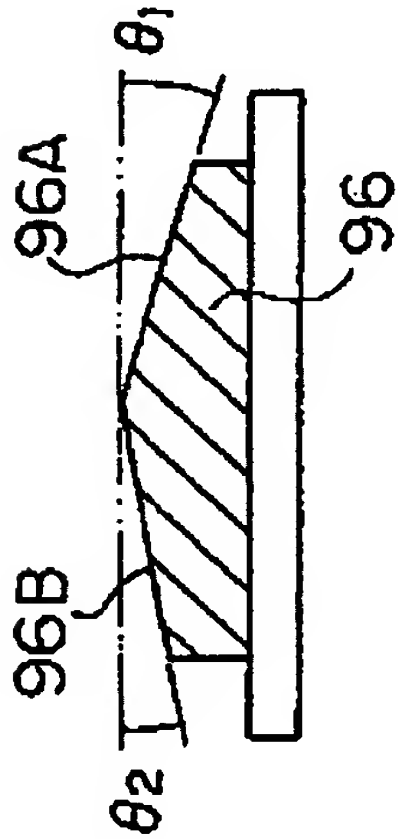


Fig.19(c)

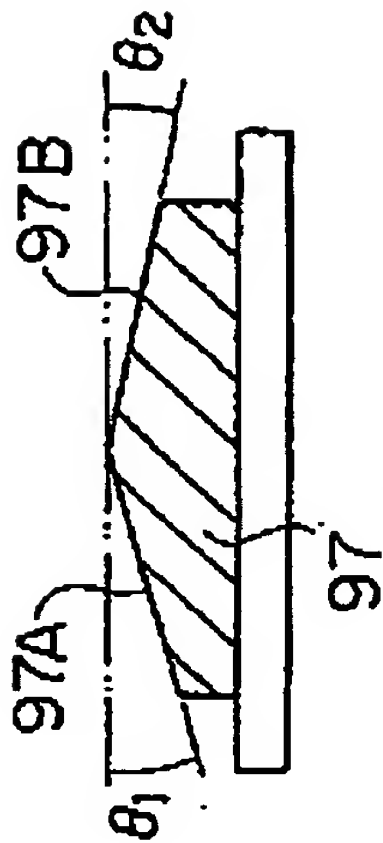


Fig.19(b)

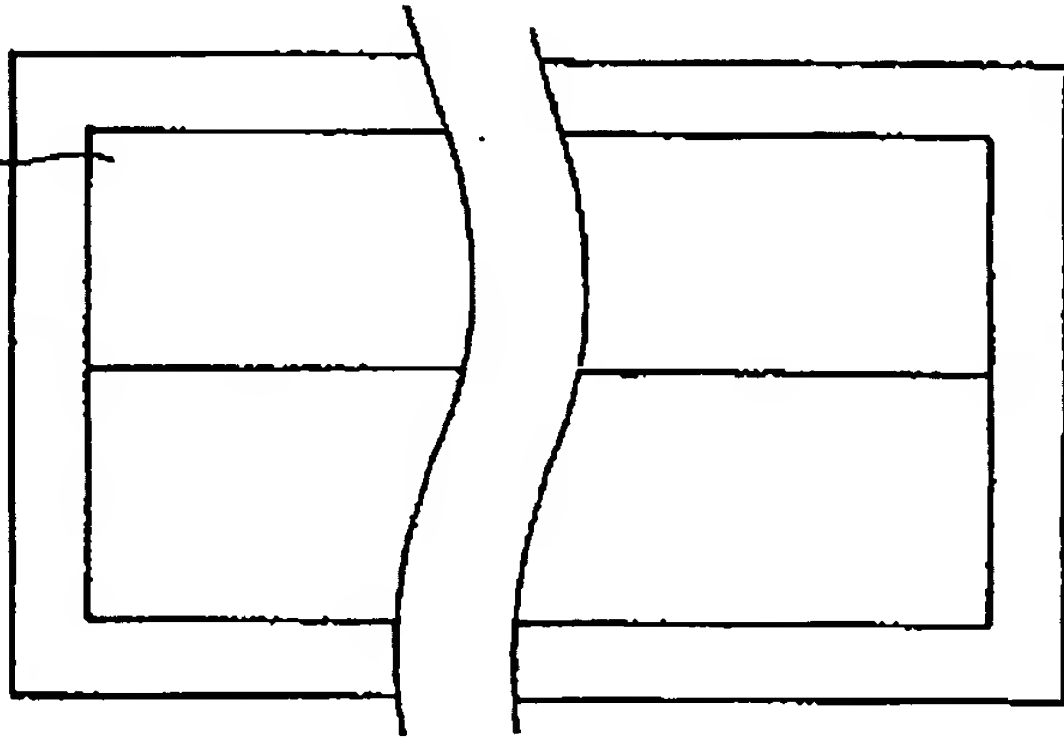


Fig.19(d)

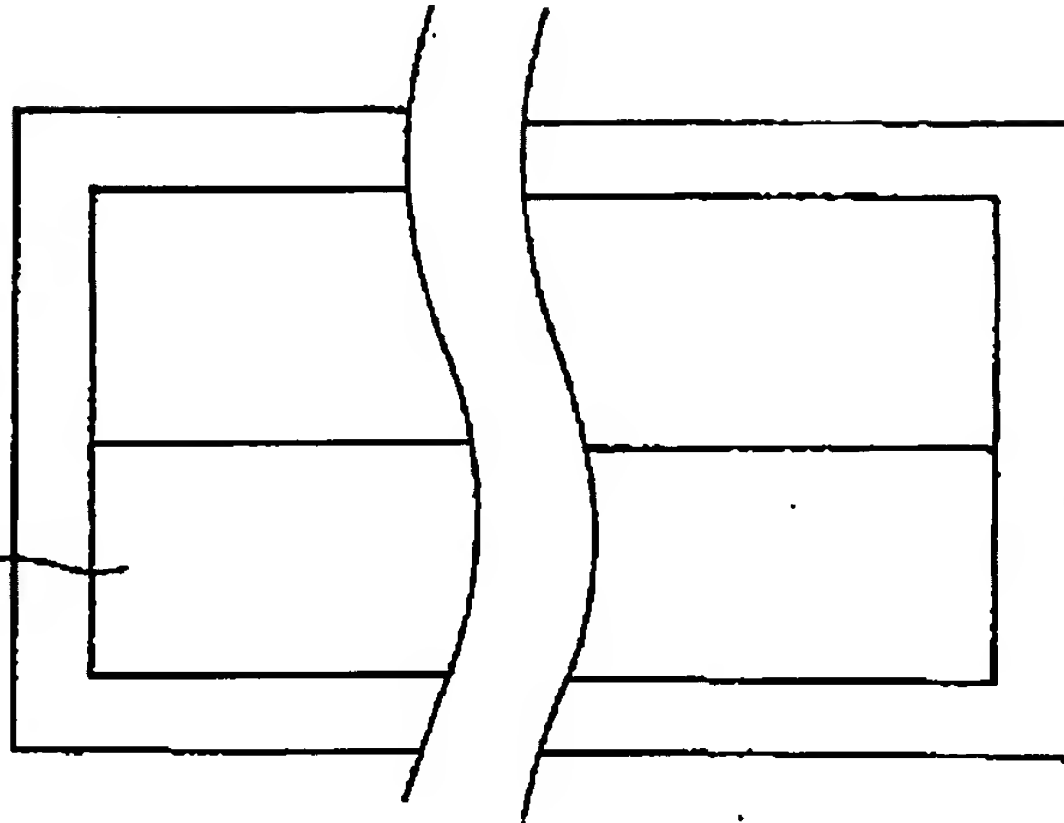


Fig. 20

Change in transmittance of light having wavelength of 550 nm when TiO_2 ($n=2.4$) is deposited on glass substrate

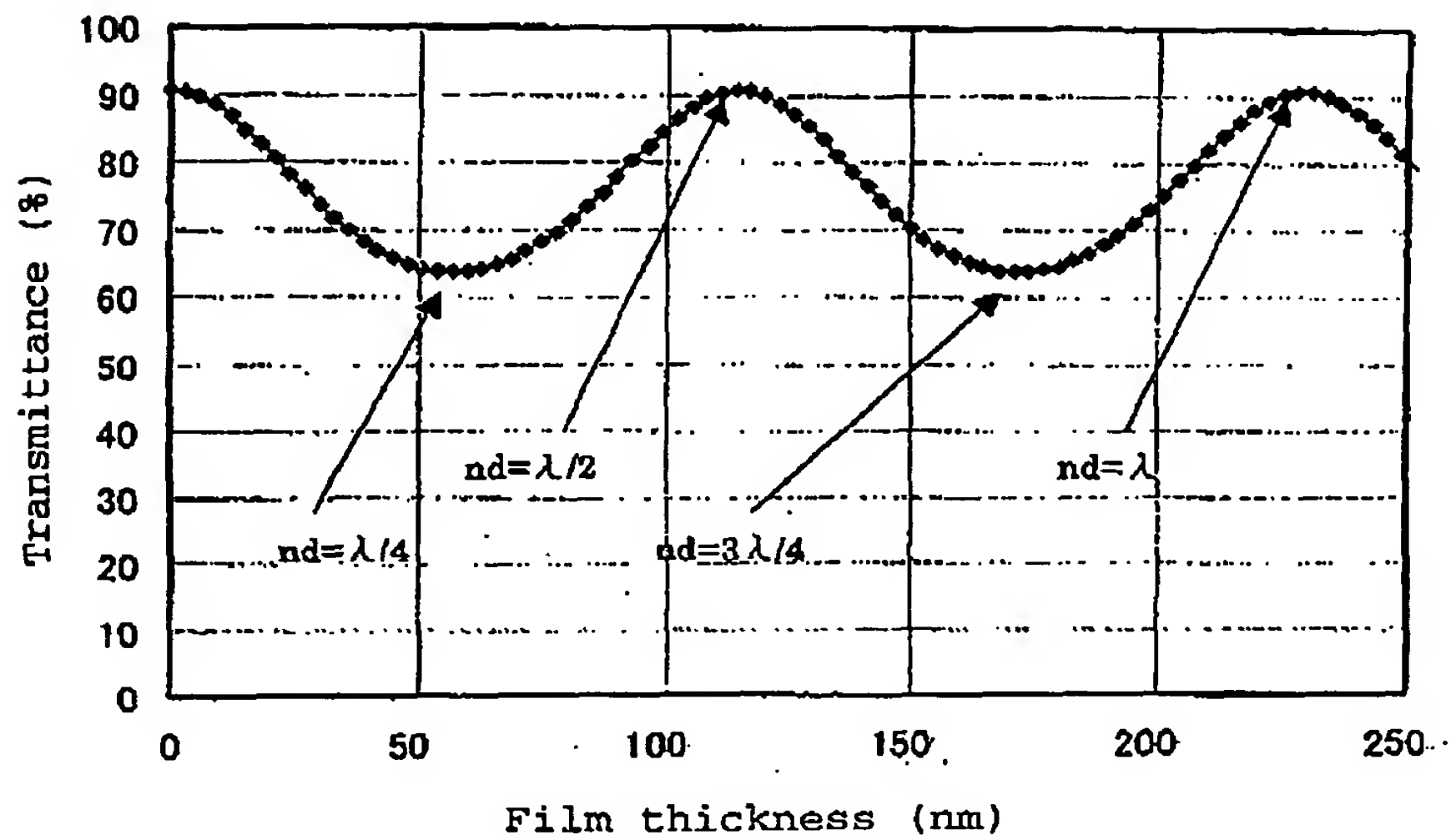


Fig. 21

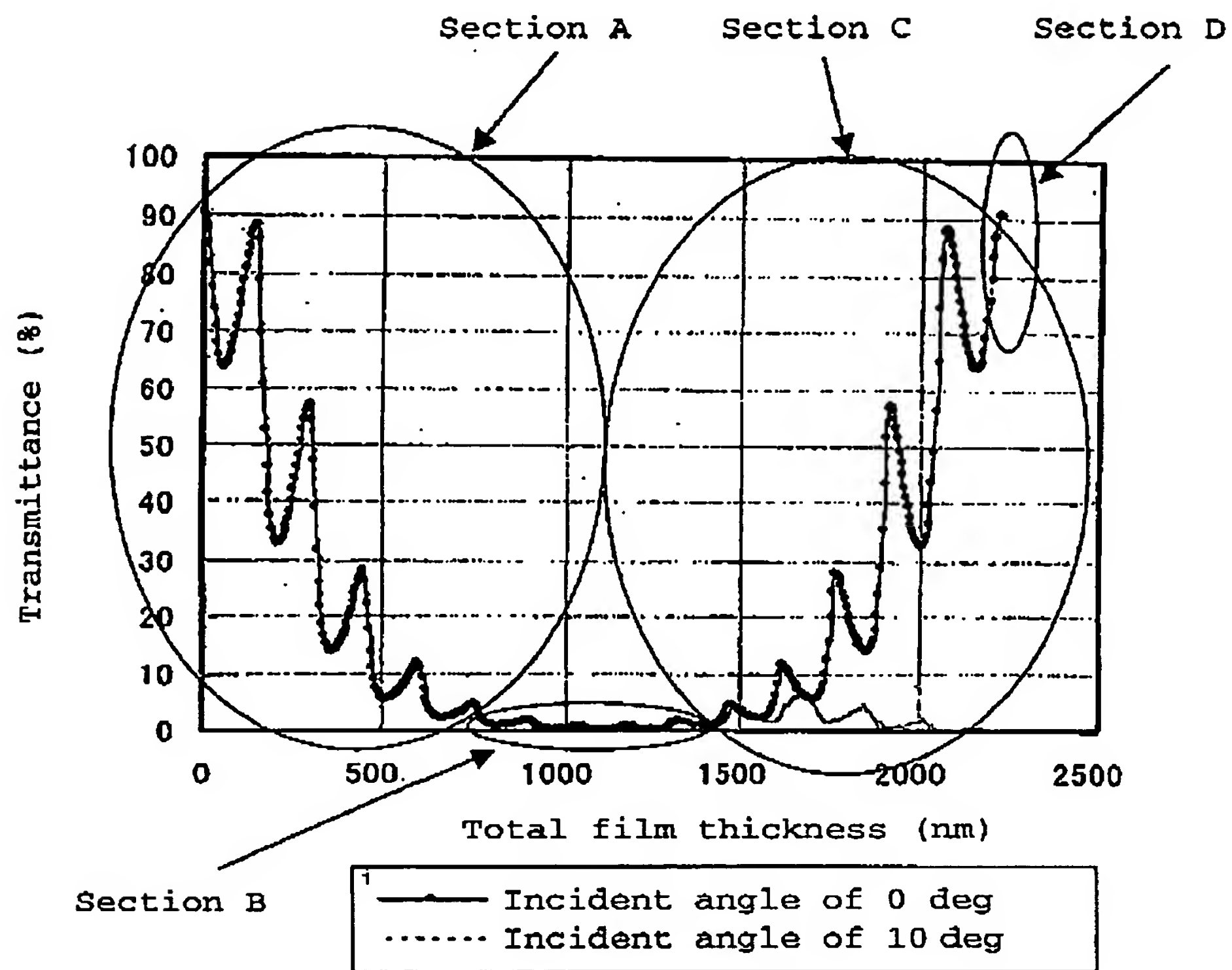


Fig. 22

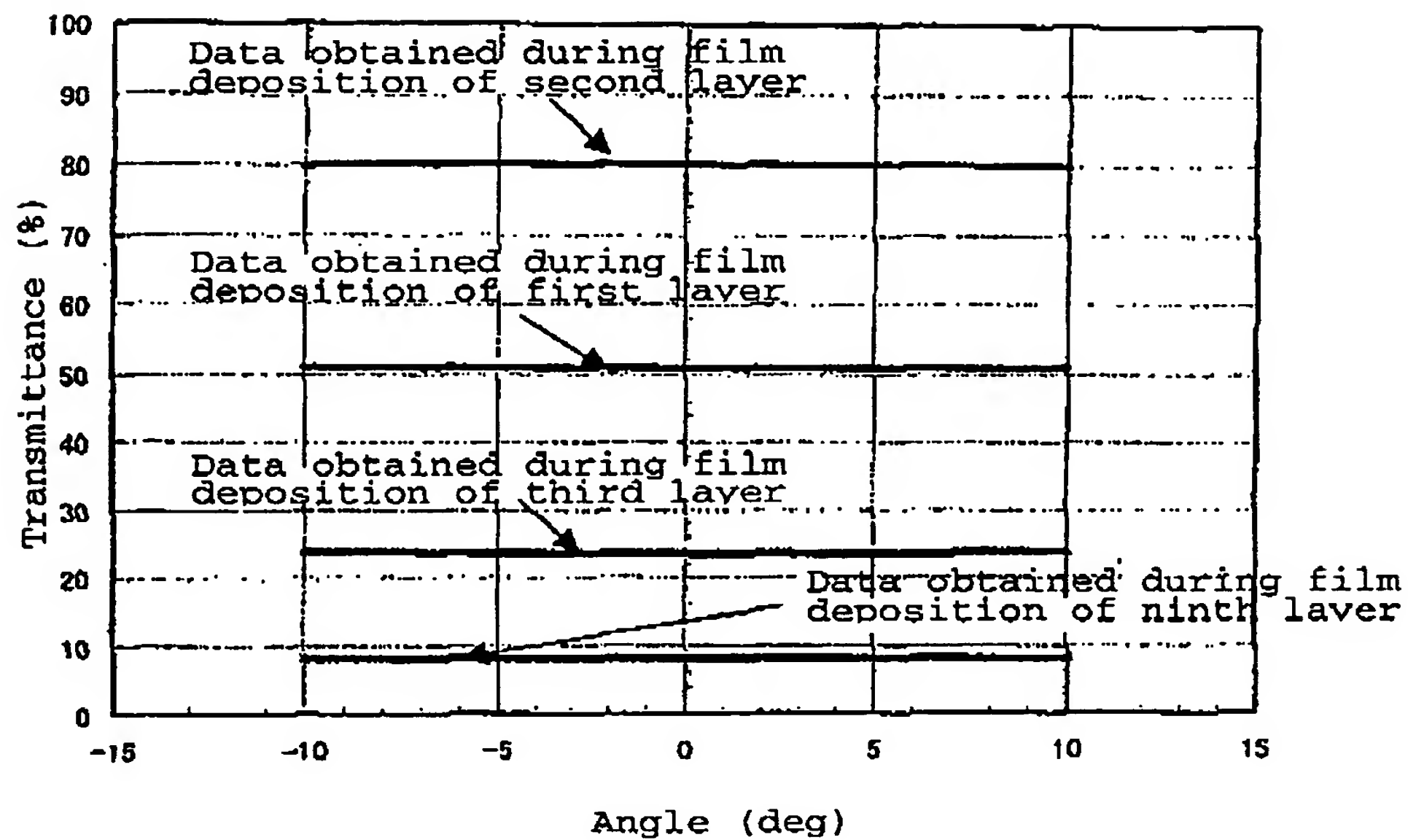
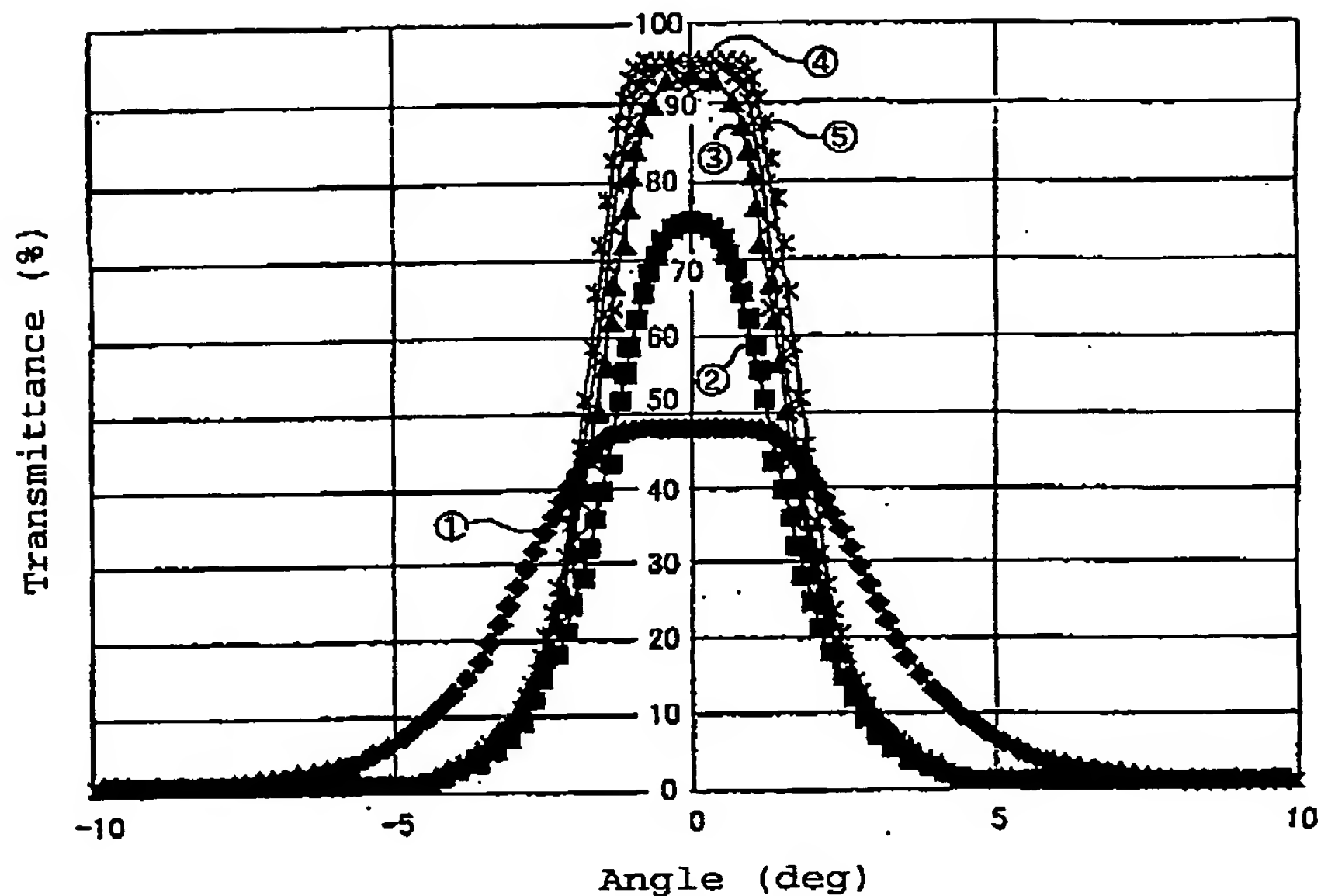


Fig. 23



- ◆— ① Completion of film deposition for 28th layer
- ② Completion of film deposition by 37.3 nm for 29th layer
- ▲— ③ Completion of film deposition by 52.2nm for 29th layer
- ×— ④ Completion of film deposition for 29th layer
- *— ⑤ Completion of film deposition by 29th layer + 20 nm

Fig. 24

Spectral transmittance for BPF having 29 layers and one cavity, and transmittance approximately converted based on measurement at incident wavelength of 550 nm

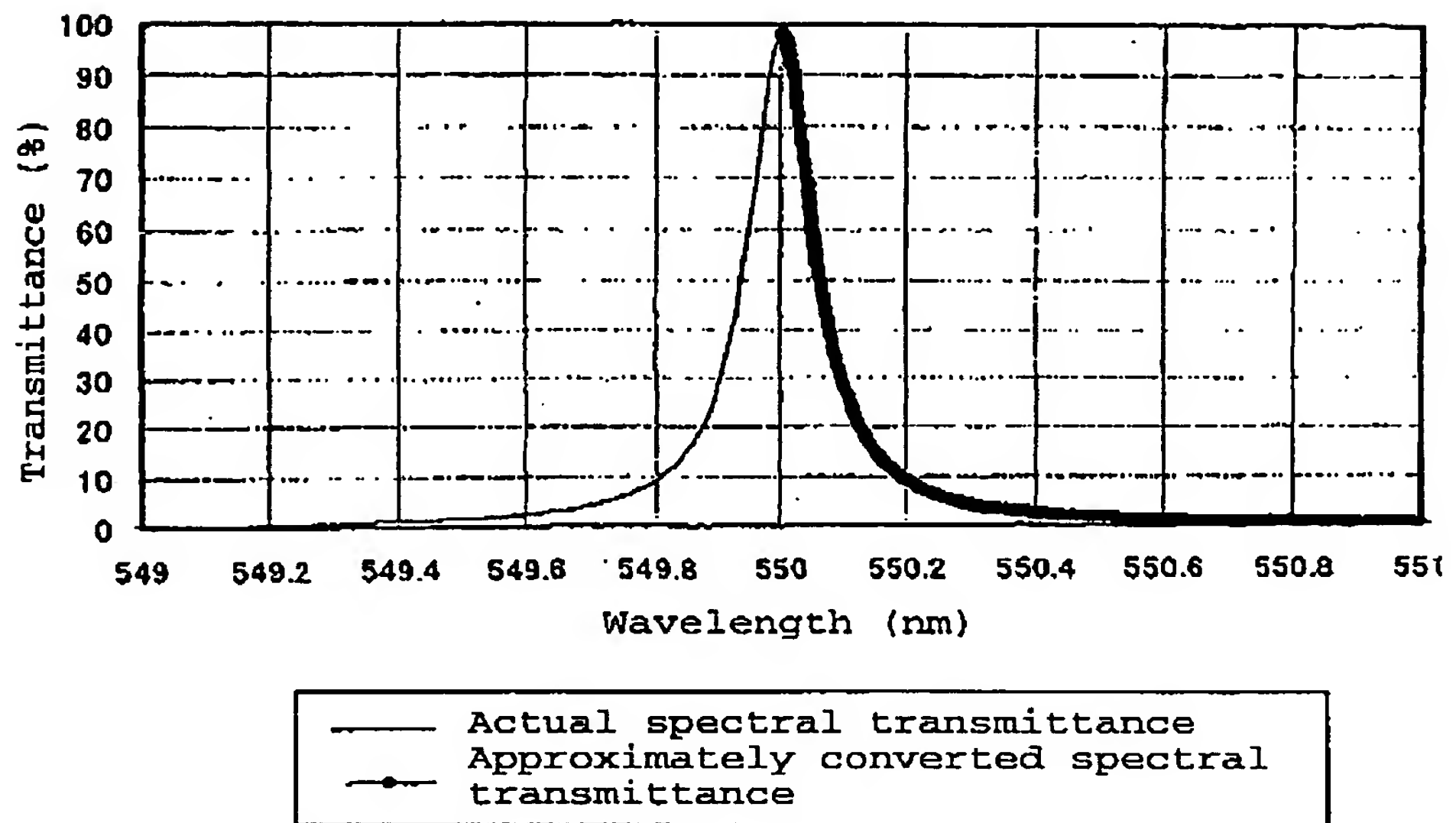


Fig. 25

Angular dependency of transmittance for BPF
having 29 layers and one cavity

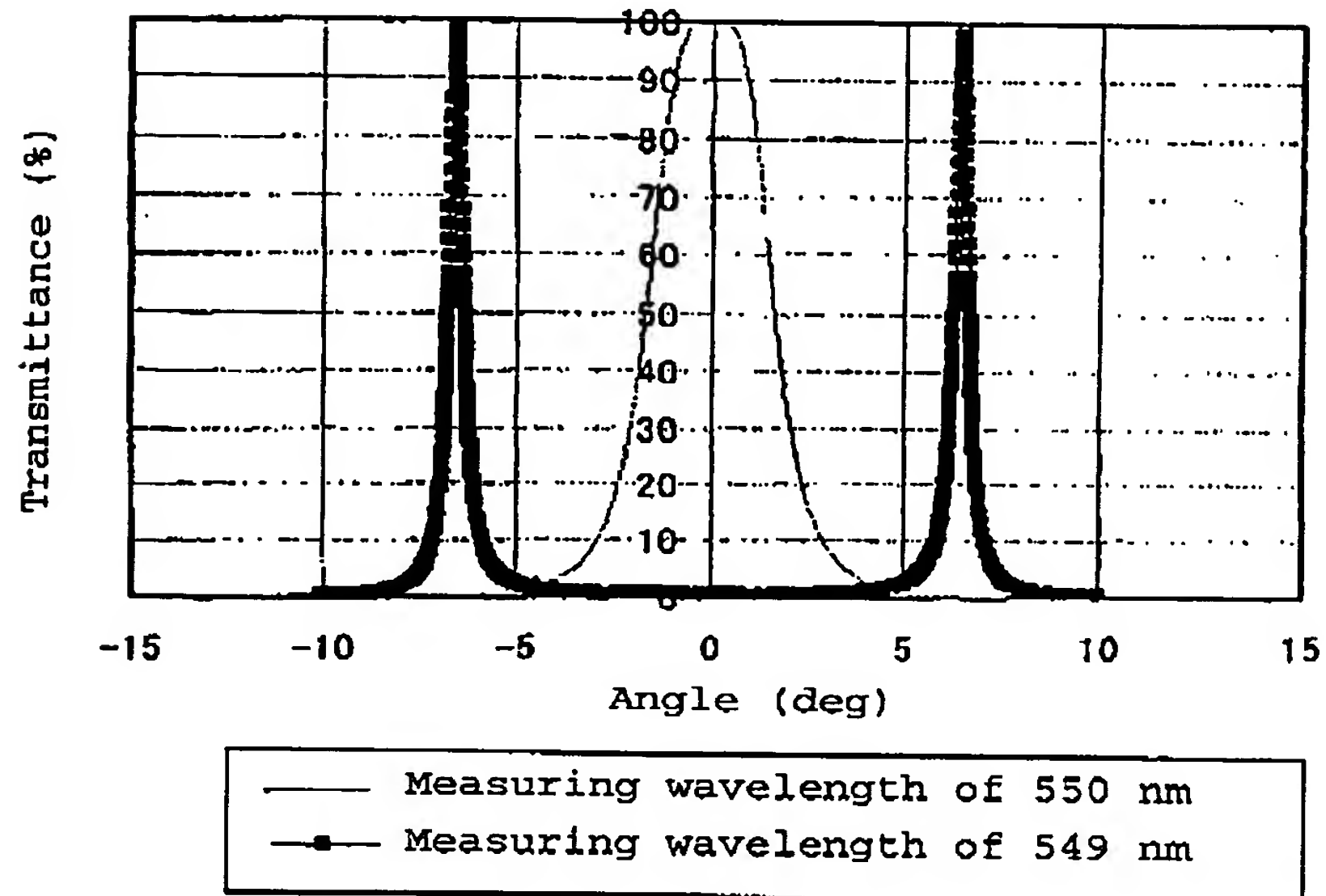


Fig. 26

Spectral transmittance for BPF having 29 layers and one cavity, and transmittance approximately converted based on measurement at incident wavelength of 549 nm

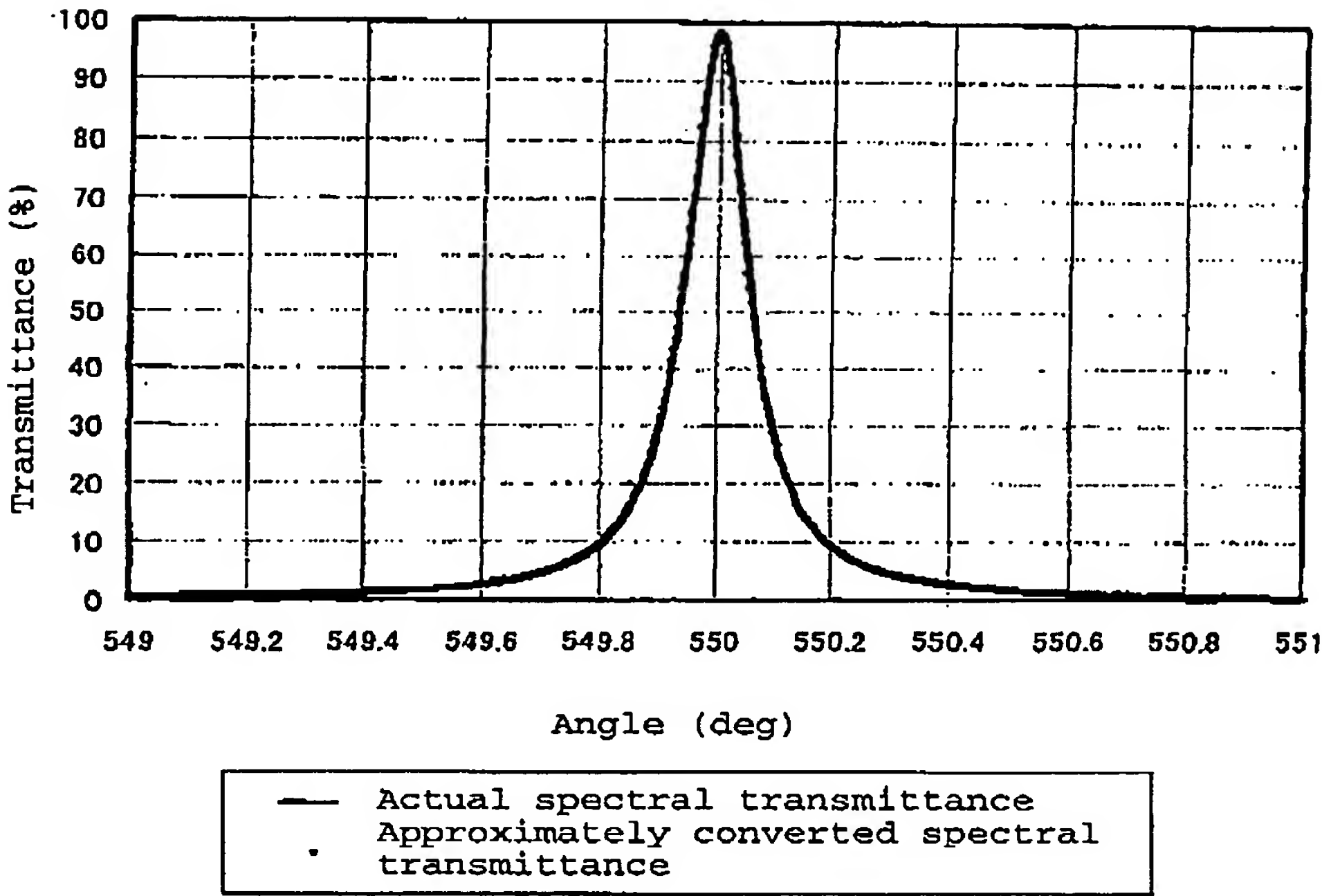
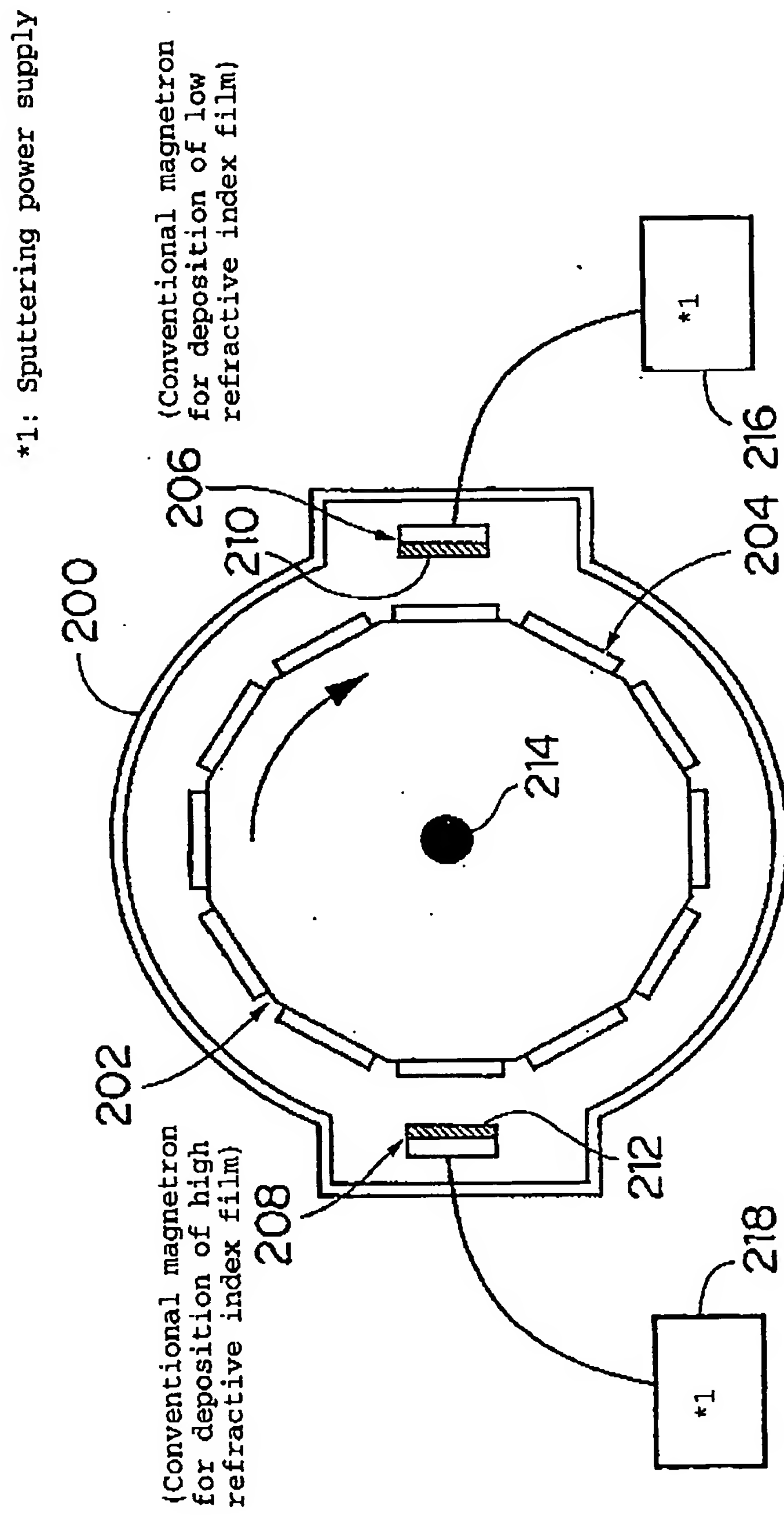


Fig. 27



F i g. 28

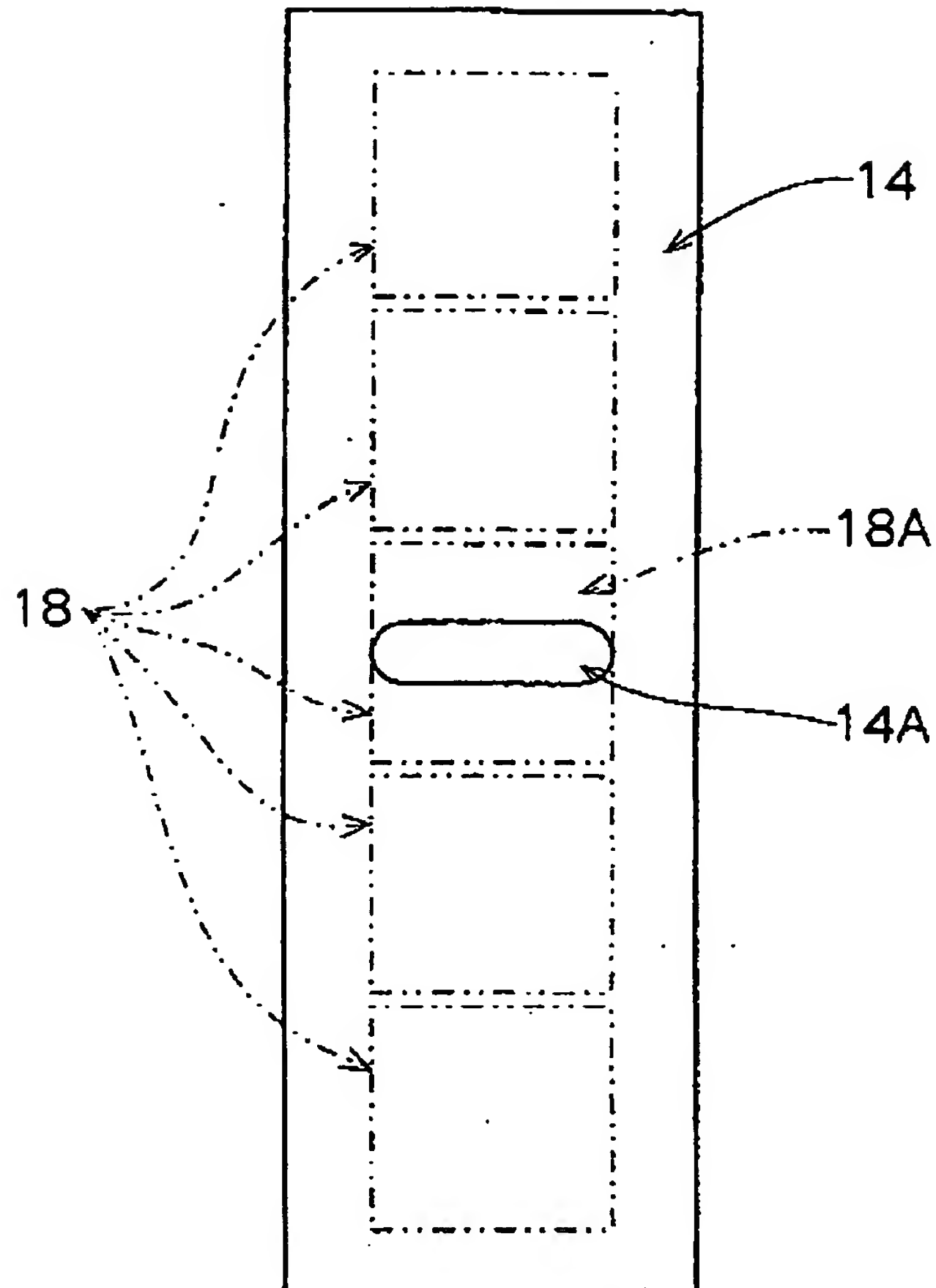


Fig. 29

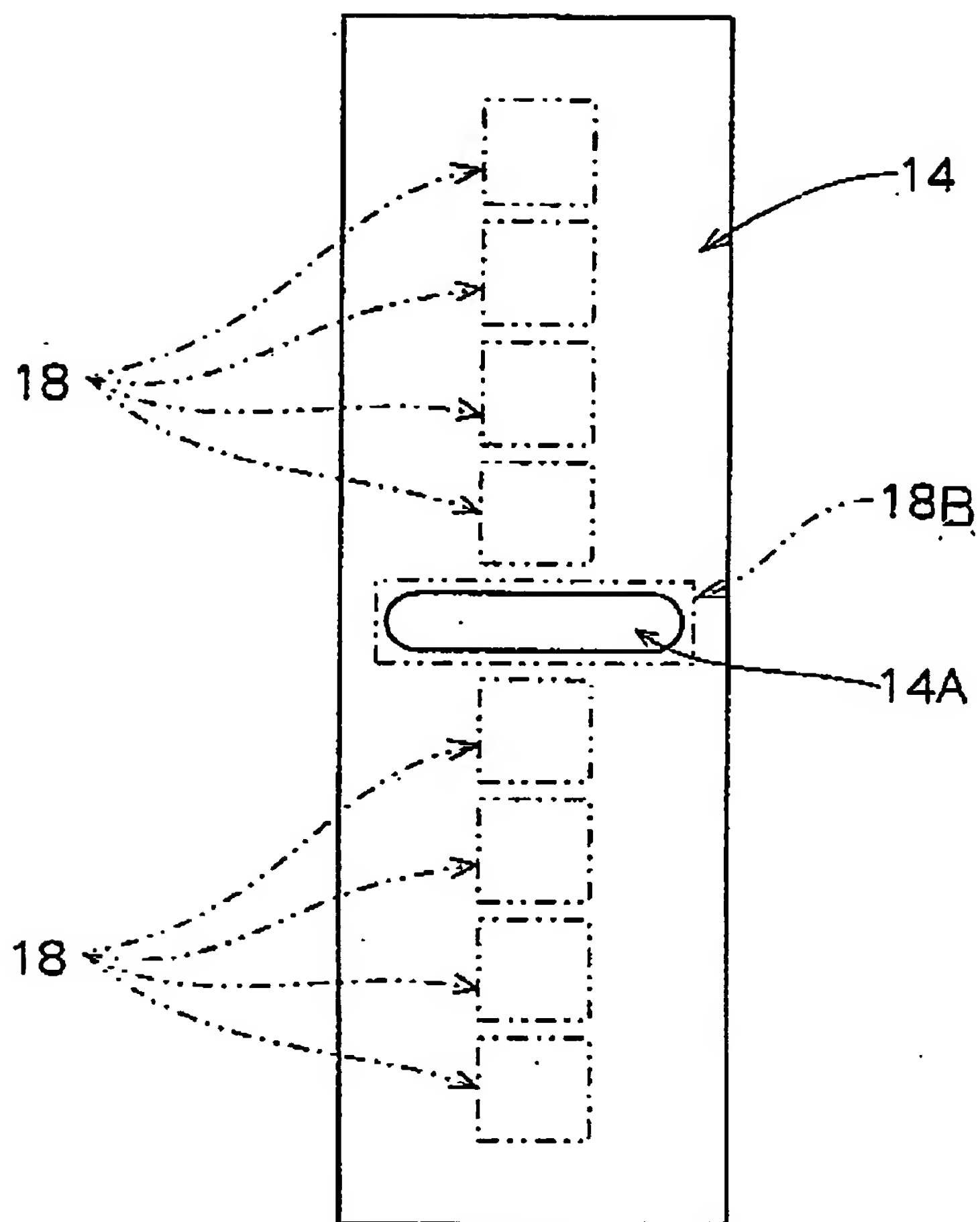


Fig. 30

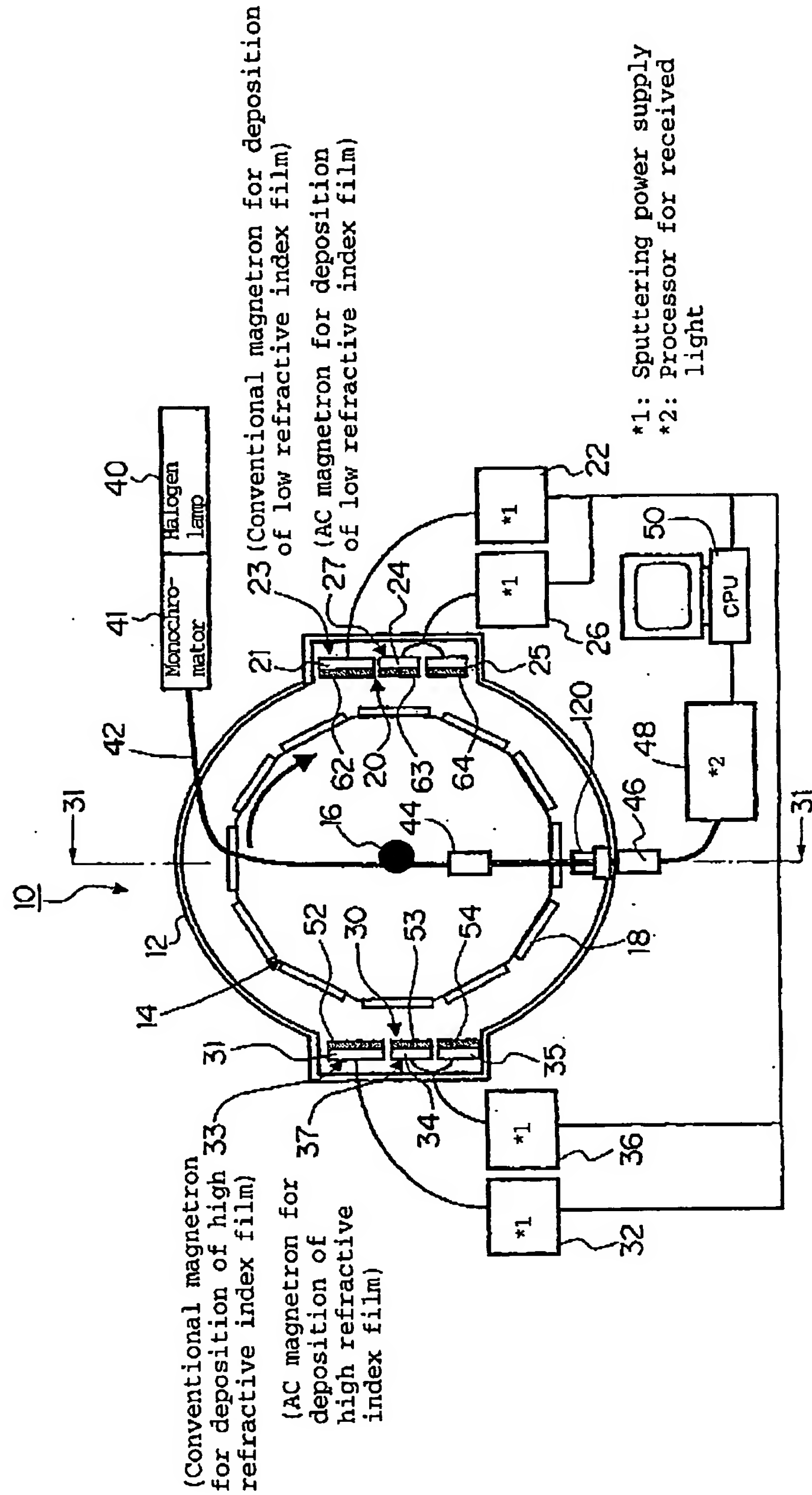
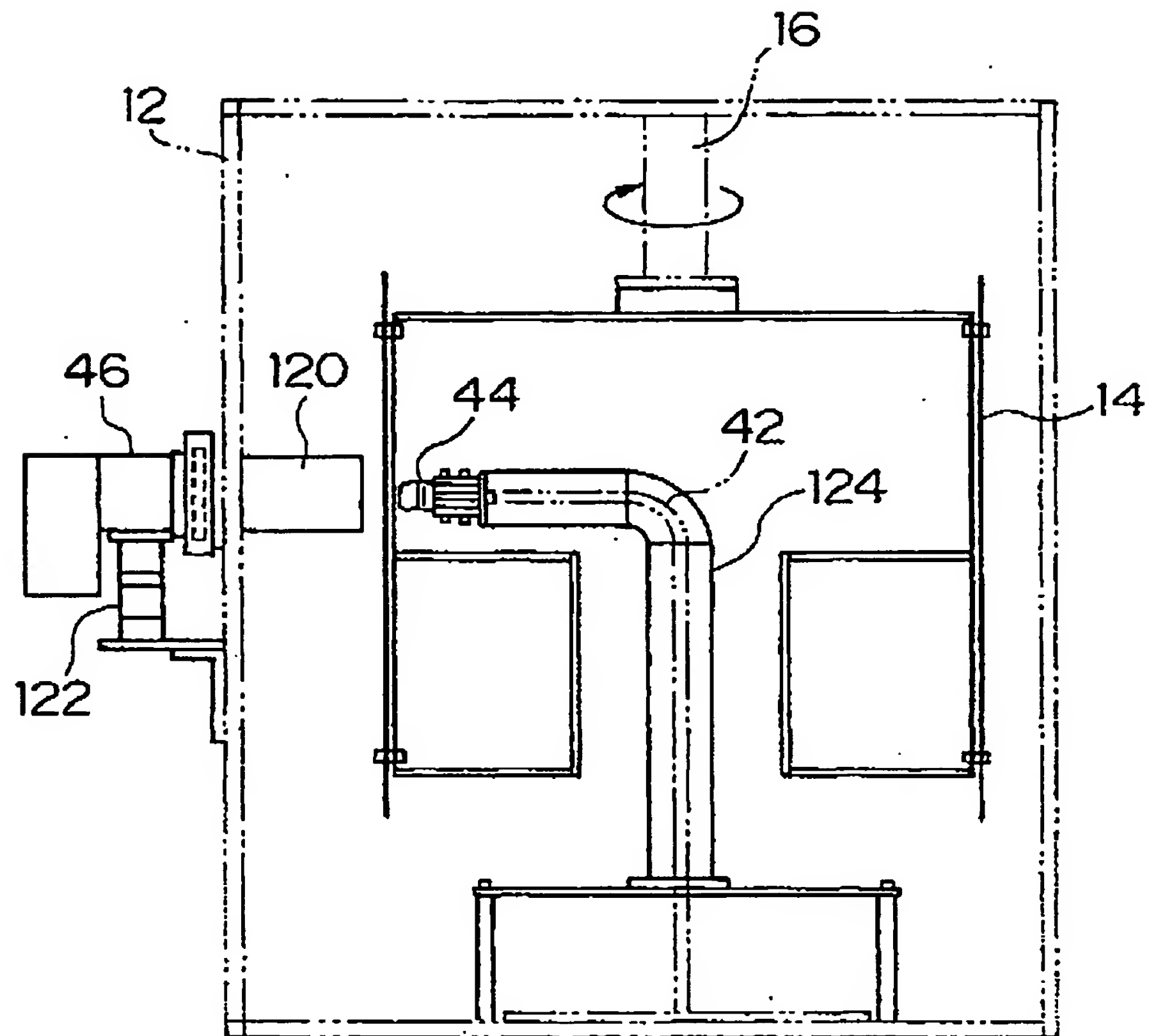
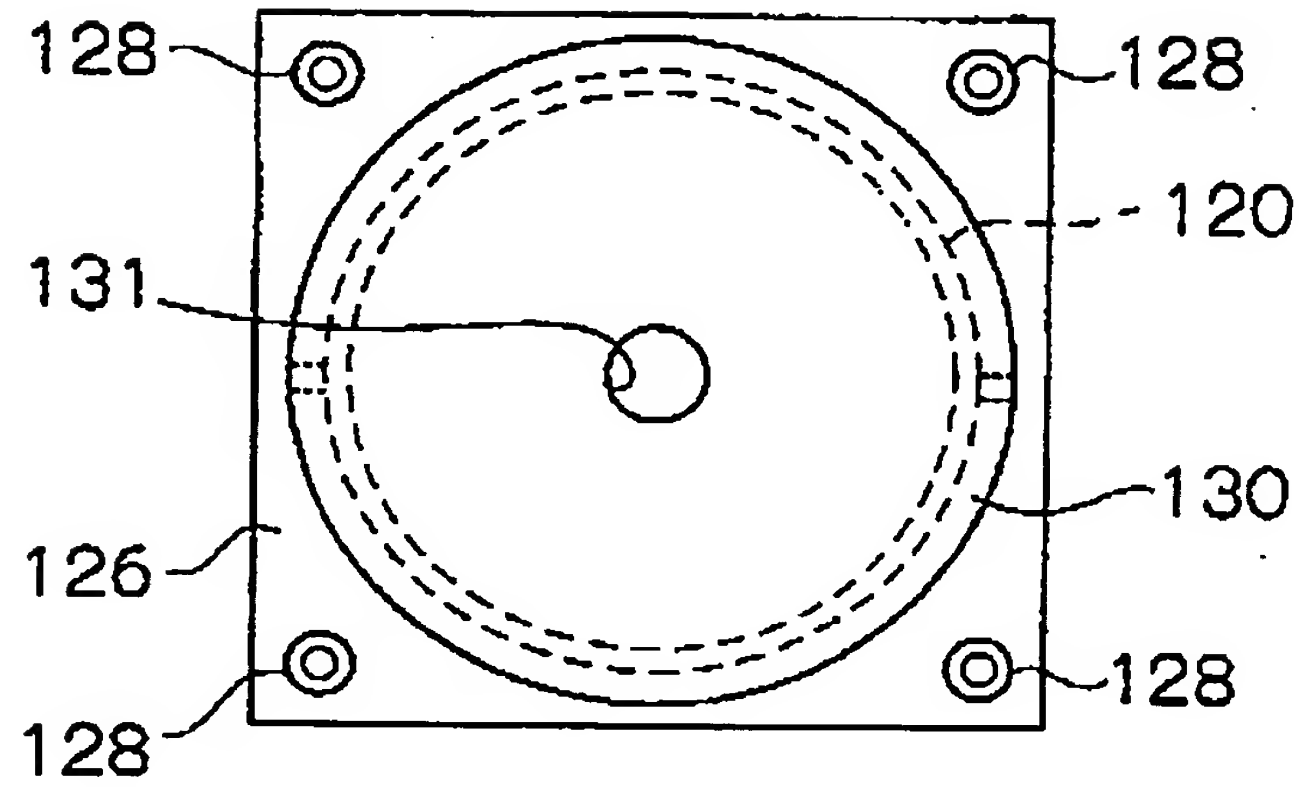


Fig. 31



F i g. 32



F i g. 33

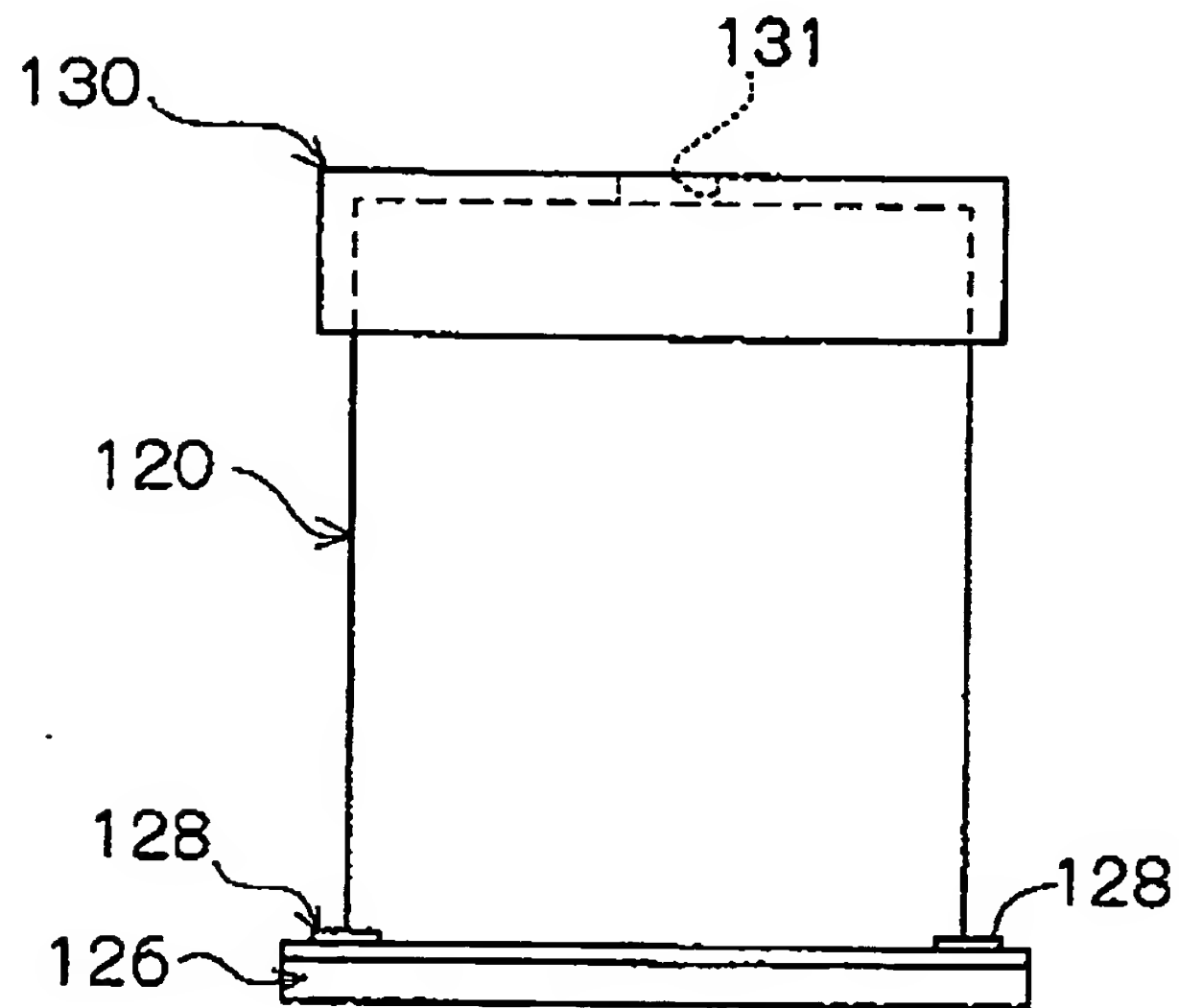


Fig. 34

Example of film structure and film deposition method

Film deposition method	Kind of film	Number of film layer	Total film thickness (target)	Required precision of film thickness	Substrate holder Number of revolution (rpm)	Application
AC (rapid deposition) method	Antireflective film	1 to 4 layers (single side)	0.1 to 0.3 μm	1 to 5% or less	8 to 60 rpm	Various kinds of cameras Displays etc.
	Infrared reflective film Ultraviolet reflective film Ultraviolet/infrared reflective film Visual light reflective film Polarized separating film	15 to 50 layers	1.5 to 4.0 μm	1% or less		Lighting equipment Projectors Various kinds of cameras Displays etc.
	Band pass filter	100 to 200 layers	25 to 35 μm	0.01% or less		For WDM communication
Method wherein AC (rapid deposition) and DC (slow deposition) are combined	Gain flattening target	30 to 40 layers	20 to 25 μm	0.01% or less	4 to 20 rpm	

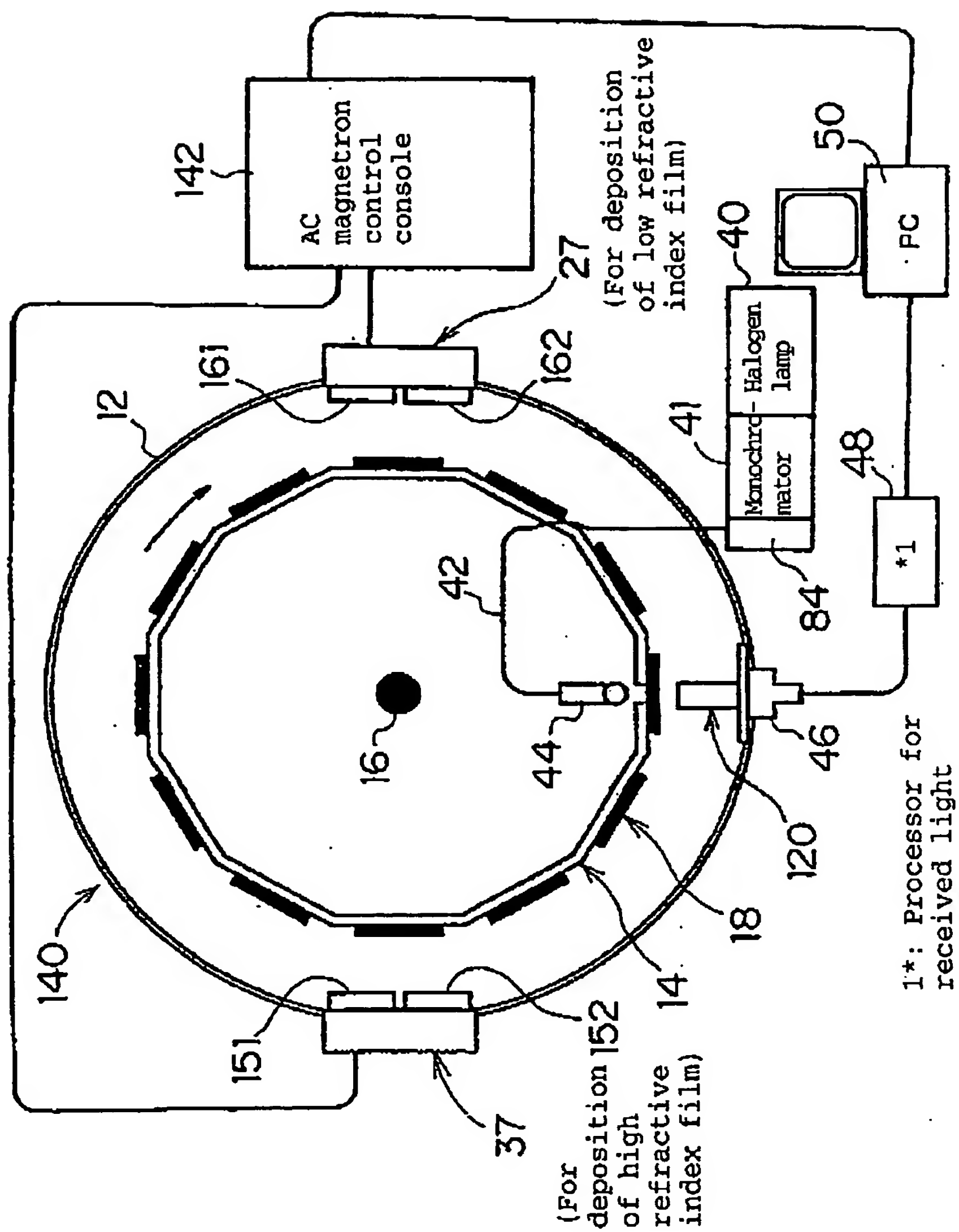


Fig. 36

Evaluation result for film property

	AC sputtering 10 layers 2.0 μm	DC sputtering 26 layers 3.0 μm	Product formed by vapor deposition 34 layers 4 μm
Film deposition rate (SiO_2) (Ta_2O_5)	42 nm \cdot m/min 52 nm \cdot m/min	11 nm \cdot m/min 6 nm \cdot m/min	-
Film stress (SiO_2) (Ta_2O_5)	-218 MPa -78 MPa	-67 MPa -217 MPa	-
Refractive index (SiO_2) (Ta_2O_5)	1.472 at 550 nm 2.17 at 550 nm	1.460 at 550 nm 2.10 at 550 nm	-
Extinction coefficient (SiO_2) (Ta_2O_5)	$< 10^{-4}$ $< 10^{-4}$	$< 10^{-4}$ $< 10^{-4}$	-
Haze value	0.0%	0.3%	0.3%
Smoothness (Ra)	0.32 nm	0.30 nm	2.22 nm
Wavelength shift (60°C, 90%RH, 120 h)	< 1 nm	< 1 nm	Less than 2 nm

(With respect to film deposition rate, film stress, refractive index and extinction coefficient, result for single film of 500 nm)

Fig. 37

Film property required for multilayer optical film

	Targeted value
Film stress (SiO ₂) (Ta ₂ O ₅)	Within range of ± 300 MPa
Refractive index (SiO ₂) (Ta ₂ O ₅)	1.45 or more and 1.48 or less 2.15 or more and 2.25 or less
Extinction coefficient (SiO ₂) (Ta ₂ O ₅)	$< 10^{-4}$ $< 10^{-4}$
Haze value	$< 0.1\%$
Smoothness (Ra)	< 1.0 nm
Wavelength shift (60°C, 90%RH, 120 h)	< 1 nm